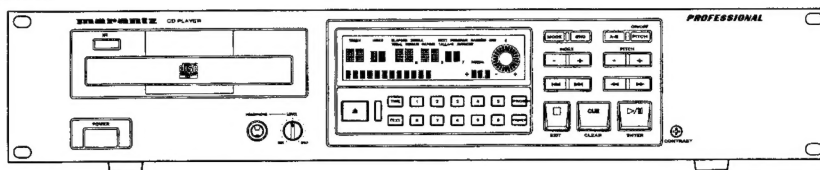


Service Manual

PMD330 /N1M, /U1B, /F1B
PMD331 /N1M, /U1B, /F1B
PMD340 /N1M, /U1B, /F1M
CD Player

PMD330



PMD331 / 340

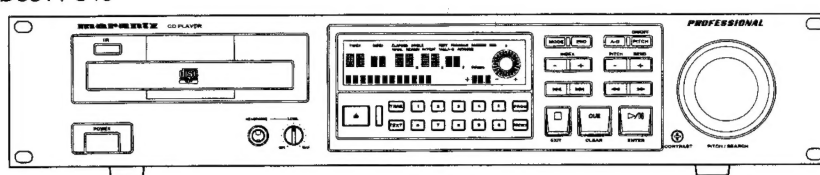


TABLE OF CONTENTS

SECTION	PAGE
1. TECHNICAL SPECIFICATIONS	1
2. SERVICE HINTS	2
3. SERVICE TOOLS	2
4. ADJUSTMENT AND SERVICE MODE	3
5. MICROPROCESSOR AND IC DATA	5
6. WIRING DIAGRAM	13
7. BLOCK DIAGRAM	15
8. SCHEMATIC DIAGRAM.....	17
9. PARTS LOCATIONS	24
10. EXPLODED VIEW AND MECHANISM PARTS LIST	28
11. TECHNICAL DESCRIPTION	31
12. ELECTRICAL PARTS LIST	33

Please use this service manual with referring to the user guide (D.F.U.) without fail.

修理の際は、必ず取扱説明書を準備し操作方法を確認の上作業を行ってください。

marantz®

PMD330 / 331 / 340

371K855010 MIT
3120 785 22250
First Issue 1999.12

MARANTZ DESIGN AND SERVICE

Using superior design and selected high grade components, **MARANTZ** company has created the ultimate in stereo sound. Only original **MARANTZ** parts can insure that your **MARANTZ** product will continue to perform to the specifications for which it is famous.

Parts for your **MARANTZ** equipment are generally available to our National Marantz Subsidiary or Agent.

ORDERING PARTS :

Parts can be ordered either by mail or by Fax.. In both cases, the correct part number has to be specified.

The following information must be supplied to eliminate delays in processing your order :

1. Complete address
2. Complete part numbers and quantities required
3. Description of parts
4. Model number for which part is required
5. Way of shipment
6. Signature : any order form or Fax. must be signed, otherwise such part order will be considered as null and void.

USA

MARANTZ AMERICA, INC.
440 MEDINAH ROAD
ROSELLE, ILLINOIS 60172
USA
PHONE : 630 - 307 - 3100
FAX : 630 - 307 - 2687

EUROPE / TRADING

MARANTZ EUROPE B.V.
P.O.BOX 80002, BUILDING SFF2
5600 JB EINDHOVEN
THE NETHERLANDS
PHONE : +31 - 40 - 2732241
FAX : +31 - 40 - 2735578

BRAZIL

PHILIP DA AMAZONIA IND. ELET. ITDA
CENTRO DE INFORMACOES AO
CEP 04698-970
SAO PAULO, SP, BRAZIL
PHONE : 0800 - 123123(Discagem Direta Gratuita)
FAX : +55 11 534. 8988

PROFESSIONAL AMERICAS SUPERSCOPE TECHNOLOGIES, INC.

MARANTZ PROFESSIONAL PRODUCTS
2640 WHITE OAK CIRCLE, SUITE A
AURORA, ILLINOIS 60504 USA
PHONE : 630 - 820 - 4800
FAX : 630 - 820 - 8103

PROFESSIONAL AUSTRALIA TECHNICAL AUDIO GROUP PTY, LTD

558 DARLING STREET,
BALMAIN, NSW 2041,
AUSTRALIA
PHONE : 61 - 2 - 9810 - 5300
FAX : 61 - 2 - 9810 - 5355

CANADA

LENBROOK INDUSTRIES LIMITED
633 GRANITE COURT,
PICKERING, ONTARIO L1W 3K1
CANADA
PHONE : 905 - 831 - 6333
FAX : 905 - 831 - 6936

AUSTRALIA

JAMO AUSTRALIA PTY LTD
1 EXPO COURT, P.O. BOX 350
MT. WAVERLEY VIC 3149
AUSTRALIA
PHONE : +61 - 3 - 9543 - 1522
FAX : +61 - 3 - 9543 - 3677

THAILAND

MRZ STANDARD CO.,LTD
746 - 754 MAHACHAI ROAD.,
WANGBURAPAPIROM, PHRANAKORN,
BANGKOK, 10200 THAILAND
PHONE : +66 - 2 - 222 9181
FAX : +66 - 2 - 224 6795

SINGAPORE

WO KEE HONG (S) PTE LTD
WO KEE HONG CENTRE
NO.23, LORONG 8, TOA PAYOH
SINGAPORE 319257
PHONE : +65 2544555
FAX : +65 2502213

NEW ZEALAND

WILDASH AUDIO SYSTEMS NZ
14 MALVERN ROAD MT ALBERT
AUCKLAND NEW ZEALAND
PHONE : +64 - 9 - 8451958
FAX : +64 - 9 - 8463554

TAIWAN

PAI- YUING CO., LTD.
6 TH FL NO, 148 SUNG KIANG ROAD,
TAIPEI, 10429, TAIWAN R.O.C.
PHONE : +886 - 2 - 25221304
FAX : +886 - 2 - 25630415

MALAYSIA

WO KEE HONG ELECTRONICS SDN. BHD.
SUITE 8.1, LEVEL 8, MENARA GENESIS,
NO. 33, JALAN SULTAN ISMAIL,
50250 KUALA LUMPUR, MALAYSIA
PHONE : +60 3 - 2457677
FAX : +60 3 - 2458180

JAPAN Technical

MARANTZ JAPAN, INC.
35- 1, 7- CHOME, SAGAMIONO
SAGAMIHARA - SHI, KANAGAWA
JAPAN 228-8505
PHONE : +81 42748 1013
FAX : +81 42741 9190

日本マランツ株式会社

本 社 〒228-8505
神奈川県相模原市相模大野7-35-1
営業本部 〒150-0022
東京都渋谷区恵比寿南1-11-9

KOREA

MK ENTERPRISES LTD.
ROOM 604/605, ELECTRO-OFFICETEL, 16-58,
3GA, HANGANG-RO, YONGSAN-KU, SEOUL
KOREA
PHONE : +822 - 3232 - 155
FAX : +822 - 3232 - 154

SHOCK, FIRE HAZARD SERVICE TEST :

CAUTION : After servicing this appliance and prior to returning to customer, measure the resistance between either primary AC cord connector pins (with unit NOT connected to AC mains and its Power switch ON), and the face or Front Panel of product and controls and chassis bottom.

Any resistance measurement less than 1 Megohms should cause unit to be repaired or corrected before AC power is applied, and verified before it is return to the user/customer.

Ref. UL Standard No. 813.

In case of difficulties, do not hesitate to contact the Technical
Department at above mentioned address.

1. TECHNICAL SPECIFICATIONS

		PMD330	PMD331 / PMD340
General specifications			
System		Compact Disc - Digital Audio	
Number of channels		2	
Compatible discs		CD-DA, CD-R, CD-RW (12 cm, 8 cm)	
Audio characteristics			
Channels		2 channels	
Frequency characteristics		20 Hz to 20 kHz +/- 0.3 dB	
Dynamic range		≥ 90 dB (1 kHz)	
S/N ratio		≥ 100 dB (1 kHz)	
Total harmonic distortion (THD)		0.005 % (1 kHz)	
Wow and flutter		Quartz precision	
Error correction method		Cross-interleave Read-Solomon code (CIRC)	
Analog output	Pin jack,unbalanced (RCA)	2.0V RMS Stereo	
	XLR jack,balanced (XLR) (variable range)	—— ——	+16 dBu /600 Ω, @ 0 dB FS (-11 dBu to +21 dBu, variable)
Digital output	Pin jack (SPDIF)	0.5 Vp-p/75 Ω	
	XLR jack (SPDIF)	——	3.5 Vp-p/110 Ω
	optical connector	——	-19 dBm
Search precision		1 frame	
Pitch control		Maximum: +/-12% in 0.1% steps	
Pitch bend control		——	+/- 8 %
Strat timing		——	20 ms
Remote control			
Infrared remote control input		IN (IR sensor)	
RC5 remote control input/output		——	RCA IN (INT/EXT switch)/OUT
Remote control input/output		——	D-SUB 25-Pin female
Optical anning method			
Laser		AlGaAs semiconductor	
Wavelength		780 nm	
Signal system			
Sampling frequency		44.1 kHz	
Quantization		16-bit linear/channel	
Power supply section			
AC power supply		/F : 100V, AC 50/60Hz, /N : 230V, AC 50Hz, /U : 120V, AC 60Hz	
Power consumption		12 W	17 W
Cabinet, etc.			
External dimensions (W x H x D)		483 x 100 x 325 mm (19 x 3-15/16 x 12- 13/16 inches)	
Weight		4.8 kg (10.6 lbs)	4.9 kg (10.8 lbs)
Operating temperature range		+ 5°C to + 35°C	
Operating humidity range		5% to 90% (without dew)	

Due to our continuing efforts to improve our products, the specifications and appearance of this product are subject to change without prior notice.

2. SERVICE HINTS

GENERAL

SERVICE PACKAGE

DISMOUNTING

A: SOLDERING IRON, VACUUM PISTON 4822 395 10082, SOLDERING IRON, e.g. WELDER solder tip PT-H7

B: SOLDERING IRON, SOLDER WICK 4822 321 40042, e.g. A PAIR OF TWEEZERS, HEATING, HEATING

C: SOLDERING IRON, SOLDER WICK, CLEANING

MOUNTING

A: e.g. A PAIR OF TWEEZERS, SOLDER ø0.5-0.8mm, PRESSURE

B: SOLDERING IRON, SOLDERING TIME < 3 sec/side, SOLDER ø0.5-0.8mm, PRESSURE, SOLDERING IRON

EXAMPLES

CORRECT

INCORRECT

PRECAUTIONS

CORRECT: SOLDERING IRON, COPPER TRACK

INCORRECT: SOLDERING IRON, CHIP COMPONENT

3. SERVICE TOOLS

Audio signals disc	4822 397 30184
Disc without errors (SBC444)+	
Disc with DO errors, black spots and fingerprints (SBC444A)	4822 397 30245
Disc (65 min 1kHz) without no pause	4822 397 30155
Max. diameter disc (58.0 mm)	4822 397 60141
Torx screwdrivers	
Set (straight)	4822 395 50145
Set (square)	4822 395 50132
13th order filter	4822 395 30204

4. ADJUSTMENT AND SERVICE MODE

1.1. Digital Output (Coaxial) Check

On the preset menu, set "D.OUT" to "ON".(PMD331/PMD340)
Do waveform observation with the oscilloscope, and confirm the digital output level of JT01 to be 0.5Vp-p, square wave within ±20% .

1.2. Balanced Output Adjustment (PMD331/PMD340)

1kHz, 0 dB are played back by using TEST disc.
Turn RB01 on the rear panel, and adjust the output of JB53 (Balanced Out L-Ch).
Turn RB02 on the rear panel, and adjust the output of JB54 (Balanced Out R-CH).
Adjust each output level to 16 dBu, within ±0.5dB.

1.3. Service Mode

- 1) With power off, simultaneously press the PLAY/PAUSE, MODE and TIME buttons, and at the same time, press the power button. At this time the LCD shows the model name and firmware version.
- 2) Next, press CUE button.
- 3) At this time the LCD shows " Test : Version ". (TEST MODE select menu)
- 4) The NEXT and PREVIOUS buttons change the TEST MODE(refer to the chart below). The PLAY button selects it.
- 5) Pressing the CUE button returns to the TEST MODE select menu.
- 6) Press the STOP button to exit the service mode.

INDEX	TEST MODE	CONTENTS
1.3.1	Version	MPU firmware version check
1.3.2	Display	LCD&LED 表示点灯テスト
1.3.3	Key&GPI	Confirmation of Buttons, GPI Control I/O and RC5
1.3.4 *	EE-PROM	Check of EEPROM Read/Write
1.3.5 *	Pickup	Manual moving of the pickup

* It is not usually necessary to confirm.

1.3.1. Model name and firmware version check

When the LCD shows "Test : Version", press the PLAY button, to see the model name and the MPU firmware version.
Pressing the CUE button returns to the TEST MODE select menu.

1.3.2. LCD and LED test

- 1) Set the LCD panel contrast adjustment screw to mechanical center. (you will feel a click.)
- 2) When the LCD shows "Test : Display", press the PLAY button.
- 3) The LCD and LED lights as the chart below.
- 4) Each time the PLAY/PAUSE button is pressed the LCD and LED change as shown in the chart below.
- 5) Pressing the CUE button returns to the TEST MODE select menu.

	LCD	BUTTON				GPI Control I/O					
		END	PITCH	PLAY	CUE	PLAY TALLY	PAUSE TALLY	CUE TALLY	FADER TALLY	INDEX	END TALLY
①	PATTERN 1	○	×	○	×	○	×	○	×	○	×
②	PATTERN 2	×	○	×	○	×	○	×	○	×	○
③	All light up	○	○	○	○	○	○	○	○	○	○
④	None light up	×	×	×	×	×	×	×	×	×	×

○ : Light × : Not Light

4. 調整とサービスモード

1.1. Digital Output (Coax) 確認

Preset Menu で "D.OUT" を "ON" に設定する。(PMD331/PMD340)
JT01のデジタル出力レベルをオシロスコープで波形観測をおこない 0.5Vp-p, +/-20%以内の矩形波である事を確認する。

1.2. Balanced Output 調整 (PMD331/PMD340)

TEST Disc を使用し 1kHz, 0dB を再生する。
背面パネルのRB01を回してJB53 (Balanced Out L-Ch)の出力を調整する。
背面パネルのRB02を回してJB54 (Balanced Out R-Ch)の出力を調整する。
各々の出力レベルを 16dBu, +/-0.5dB 以内に調整する。

1.3. SERVICE モードでの確認

電源OFFの状態で、Play/Pause ボタン、Modeボタン、Time ボタンを同時に押しながら電源を入れる。
または電源ONの状態です外線リモコンからサービスコードを送ることにより、サービスモードに入る。この時、LCDにはモデル名とMPUファームウェアのバージョン表示される。
次に、CUEボタンを押す。
この時、LCDの表示が "Test : Version " となる。(Test mode 選択画面)
NextとPrevious ボタンでTest mode(下表参照)を切り替え、Play ボタンで選択する。
CUEボタンでTest mode 選択画面の状態に戻る。
Stopボタンでサービスモードを終了する。

確認項目	Test mode	内容
1.3.1	Version	MPU のファームウェアのバージョン表示
1.3.2	Display	LCD&LED 表示点灯テスト
1.3.3	Key&GPI	ボタン、GPI Control I/O, RC5 の入力表示
1.3.4 *	EE-PROM	EEPROM Read/Write のチェック
1.3.5 *	Pickup	ピックアップを手動で動作させる

* 印の項目は通常確認の必要は無い。

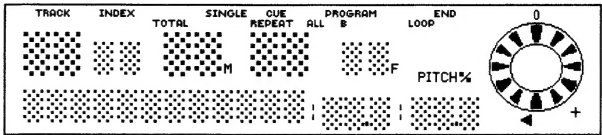
1.3.1. モデル名／プログラムバージョンの確認

"Test : Version" と表示されているときに、Play ボタン押すと、モデル名とMPUファームウェアのバージョンが表示される。
CUEボタンを押すと Test mode 選択画面 の状態に戻ります。

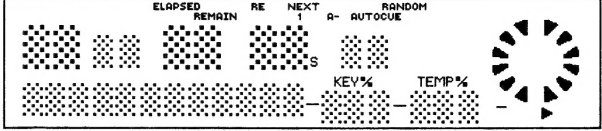
1.3.2. LCD 表示& LED点灯の確認

あらかじめ前面パネルのコントラスト調整用ボリュームRYO1をメカニカルセンターでクリックする位置に調整する。
"Test : Display " と表示されているときに、Play ボタン押すと、下記表に従ってLCDとLEDが点灯される。 Play ボタンを押す毎にLCDとLEDは下表の順に表示・点灯が切り替わる。
CUEボタンを押すと Test mode 選択画面 の状態に戻ります。

PATTERN 1



PATTERN 2



- 1.3.3. Confirmation of Buttons, GPI Control I/O and RC5
- 1) When the LCD shows "Test : Key&GPI", press the PLAY button.
- 2) The LCD shows "No Signal".
- 3) Press a button, GPI Control I/O and RC5 are input, and the LCD changes as shown in the chart below.

FUNCTION	SW Input	GPI * Input	RC5 Input	FUNCTION	SW Input	GPI * Input	RC5 Input
Open/Close	28	--	29	Preset	33	--	34
Time	29	--	30	Index +	17	8	18
CD-Text	30	--	31	Index -	18	9	19
Mode	31	--	32	0	1	--	2
Stop ***	--	--	--	1	2	--	3
Cue ****	--	--	--	2	3	--	4
Play/Pause	11	--	--	3	4	--	5
Play	--	1	12	4	5	--	6
Cue + Play	13	4	--	5	6	--	7
Pause	--	2	13	6	7	--	8
Next	15	10	16	7	8	--	9
Previous	16	11	17	8	9	--	10
FF	19	6	20	9	10	--	11
REW	20	7	21	Pitch Bend +*	26	--	27
END	22	--	23	Pitch Bend -*	27	--	28
A-B Repeat	21	--	22	Service	--	--	35
Pitch +	24 **	13	25	Fader (Normal)	--	Fader Input	--
Pitch -	25 **	14	26	Fader (Invert)	--	Fader Input	--
Program	32	--	33				
Pitch On/Off	23	15	24				

* : PMD331, PMD340 only. ** : PMD330 only.
*** : The service mode is exited.
**** : The TEST MODE select menu is returned.

1.3.4. Check of EEPROM Read/Write

- 1) When the LCD shows "Test : EE-PROM", press the PLAY button.
- 2) Check of EEPROM Read/Write begins. The check takes about 1 minute. During the check pressing any button has no effect.
- 3) At this time the LCD shows as the following order.
"ADDR (LOW)"--->"WRITE (LOW)"--->"WRITE (HIGH)"
--->"PAGE WRITE"--->"EEPROM OK!"
- 4) If there is an error in the EEPROM, the LCD shows "EEPROM NG!".
- 5) Pressing the CUE button returns to the TEST MODE select menu.

1.3.5. Manual moving of Pick up

- 1) When the LCD shows "Test : Pickup", press the PLAY button.
- 2) The LCD shows "Laser power". The laser diode turns on.
- 3) Press the NEXT button. The sled will move to the outside.
- 4) Press the PREVIOUS button. The sled will move to the inside.
- 5) Pressing the CUE button returns to the TEST MODE select menu.

-パターン1表示

1.3.3. ボタン、GPI Control I/O, RC5 の確認

"Test : Key&GPI" と表示されているときに、Play ボタン押すと "No Signal" と表示が変わり入力された信号源と種類を下記の表に従いLCDに表示する。

* : PMD331, PMD340 のみ。
** : PMD330 のみ。
*** : サービスモードが終了する。
**** : Test mode 選択画面 の状態に戻ります。

1.3.4. EEPROM のRead/Writeチェック

"Test : EE-PROM" と表示されているときに、Play ボタン押すとEEPROMのRead/Write チェックを始めます。チェックに要する時間は約1分間です。
チェック中は一切のボタン操作が無効となります。
この時LCDには "ADDR (LOW)" --> "WRITE (LOW)" --> WRITE (HIGH) --> "PAGE WRITE" --> "EEPROM OK !" のように表示されます。
EEPROMに不具合がある場合は、"EEPROM NG !" が表示されます。
CUEボタンを押すと Test mode 選択画面 の状態に戻ります。

1.3.5. Pickup の手動移動

"Test :Pickup" と表示されているときに、Play ボタン押すと "Laser power" と表示が変わりLaser Diode がONします。
Nextボタンで外周へ、Previous ボタンで内周へスレッドが移動します。
CUEボタンを押すと Test mode 選択画面 の状態に戻ります。

5. MICROPROCESSOR AND IC DATA

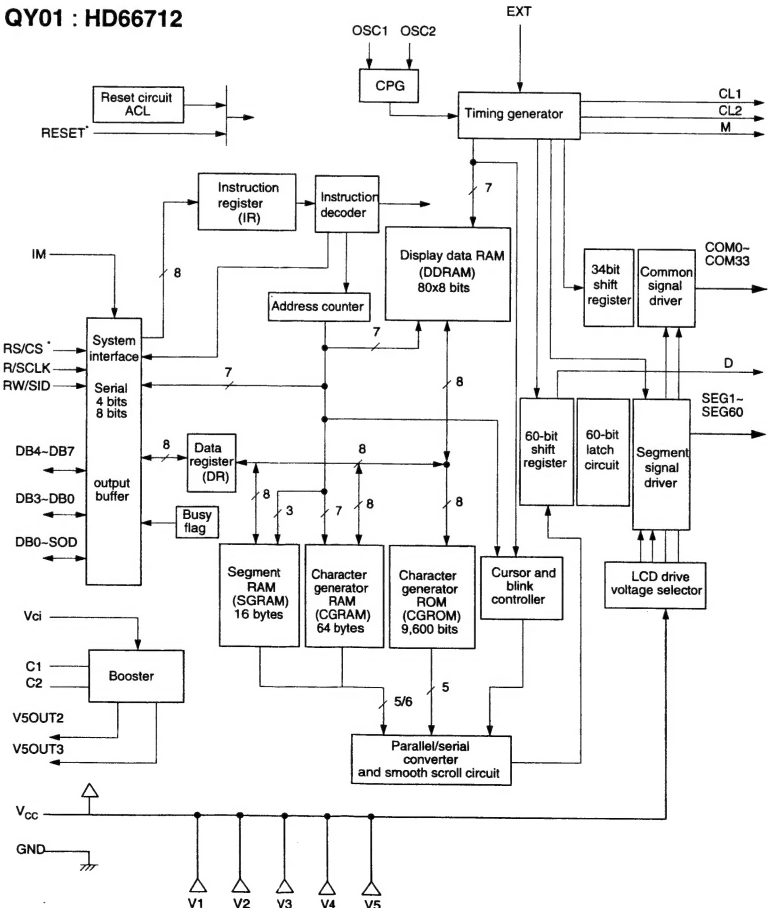
QU01 : H8/3062

PIN No.	PORT NAME	DEV ICE I/O	I/O	ACTIVE	INITIAL	PULL UP/DOWN	SIGNAL NAME	CONNECT DEVICE NAME	CONNECT DEVICE PORT NAME	FUNCTION
1	Vcc	sys	--	--	--	--	VCC			Connected to the system power supply (+5V).
2	PB0 /TP8/TMO0	I/O	O	--	Low	--	LCD_RS	HD66712	RS	LCD driver register select. Instruction "L". Data register "H".
3	PB1 /TP9/TMO1	I/O	O	--	High	--	LCD_RW	HD66712	RW	LCD driver READ/WRITE. READ "H", WRITE "L".
4	PB2 /TP10/TMO2	I/O	O	--	Low	--	LCD_E	HD66712	E	LCD driver enable. Data READ/WRITE active signal.
5	PB3 /TP11/TMO3	I/O	O	Low	High	--	LCD_RESET	HD66712	RESET	LCD driver reset. Normal "H", Reset "L".
6	PB4 /TP12	I/O	I/O	--	Low	--	LCD_DB4	HD66712	DB4	LCD driver data bit 0.
7	PB5 /TP13	I/O	I/O	--	Low	--	LCD_DB5	HD66712	DB5	LCD driver data bit 1.
8	PB6 /TP14	I/O	I/O	--	Low	--	LCD_DB6	HD66712	DB6	LCD driver data bit 2.
9	PB7 /TP15	I/O	I/O	--	Low	--	LCD_DB7	HD66712	DB7	LCD driver data bit 3.
10	RESO // FWE	sys	I	Low	Low	EXT_DW	FEW	74HC00		FLASH MPU program enable signal. Enabled "H".
11	Vss	sys	--	--	--	--	VSS			Connected to the system power supply (0V).
12	P90/TxD0	O	O	--	Low	--	DEBUG_TXD			TXD for debug mode.
13	P91/TxD1	O	O	--	Low	--	FLASH_TXD			TXD for FLASH MPU program.
14	P92/RxD0	I	I	--	Low	--	DEBUG_RXD			RXD debug mode.
15	P93/RxD1	I	I	--	High	INT UP	CXD_SQSO /FLASH_RXD	CXD2585Q /74HC00	SQSO	Sub-Q 80bit/PCM peak level data input & CD-TEXT data input./RXD for FLASH MPU program.
16	P94 /SCK0/IRQ4	I/O	I	--	Low	EXT_DW	SIF_SO	74HC165		Parallel to serial IC (74HC165) data input.
17	P95 /SCK1/IRQ5	I/O	O	--	High	INT UP	CXD_SQCK	CXD2585Q	SQCK	Read out clock output for SQSO.
18	PA0	I/O	O	--	High	OPEN	ESA_SDTI	RL5C357	SDTI	Serial data output for ESA.
19	PA1	I/O	O	--	High	OPEN	ESA_SCK	RL5C357	SCK	Serial clock data output for ESA.
20	PA2	I/O	O	--	High	OPEN	ESA_XLT	RL5C357	XLT	Serial latch data output for ESA.
21	PA3	I/O	O	Low	High	OPEN	ESA_XSOE	RL5C357	XSOE	Enabled signal for ESA serial data. Enable "L".
22	Vss	sys	--	--	--	--	VSS			Connected to the system power supply (0V).
23	PA4	I/O	O	Low	High	OPEN	ESA_XRST	RL5C357	XRST	System reset output for ESA. Reset "L".
24	PA5	I/O	O	Low	High	OPEN	ESA_XWRE	RL5C357	XWRE	Write enable output for ESA. Enable "L".
25	PA6	I/O	O	Low	High	OPEN	ESA_XQOK	RL5C357	XQOK	Sub-code Q signal output for ESA. OK "L".
26	PA7	I/O	I	--	High	EXT_DW	ESA_SDT0	RL5C357	SDT0	Serial data input from ESA.
27	P30	I/O	I	Low	High	EXT_DW	ESA_XWIH	RL5C357	XWIH	Write enable signal from ESA. Disable "L".
28	P31	I/O	I	High	Low	EXT_DW	ESA_CHDT	RL5C357	CHDT	Data monitor input from ESA. Monitoring "H".
29	P32	I/O	O	High	Low	--	CXD_RW_SEL	CXD2585Q	LOCK	RF gain select for CD-RW CD-RW "H", CD-DA & CD-R "L".
30	P33	I/O	O	High	Low	--	CXD_LDON			Laser diode ON/OFF control.
31	P34	I/O	I	--	Low	--	CXD_FOK	CXD2585Q	FOK	Focus lock detect input.

PIN No.	PORT NAME	DEV ICE I/O	I/O	ACTIVE	INITIAL	PULL UP/DOWN	SIGNAL NAME	CONNECT DEVICE NAME	CONNECT DEVICE PORT NAME	FUNCTION
32	P35	I/O	I	Low	Low	--	CXD_LOCK	CXD2585Q	LOCK	GFS lock input.
33	P36	I/O	I	Low	Low	--	CXD_SSTP	CXD2585Q	SSTP	Disc inside detect input.
34	P37	I/O	O	Low	High	--	CXD_XRST	CXD2585Q	XRST	System reset output. Reset "L".
35	Vcc	sys	--	--	--	--	VCC			Connected to the system power supply (+5V).
36	P10	I/O	O	High	Low	--	CXD_DOUT_OFF	CXD2585Q	MD2	Digital audio data output ON/OFF. ON "H".
37	P11	I/O	O	High	High	--	CXD_MUTE	CXD2585Q	MUTE	Mute control output. Mute "H".
38	P12	I/O	O	--	High	--	CXD_DATA	CXD2585Q	DATA	Serial data output for CXD2585Q.
39	P13	I/O	O	--	High	--	CXD_XLAT	CXD2585Q	XLAT	Serial latch data output for CXD2585Q.
40	P14	I/O	O	--	High	--	CXD_CLOCK	CXD2585Q	CLOCK	Serial clock data output. For CXD2585Q.
41	P15	I/O	O	--	High	--	CXD_SCLK	CXD2585Q	SCLK	Clock output for SENS serial data read.
42	P16	I/O	I	--	Low	--	CXD_SENS	CXD2585Q	SENS	SENS signal input.
43	P17	I/O	I	--	Low	EXT_DW	CXD_EMPH	CXD2585Q	EMPH	Emphasis enable/disable input. Enable "H", Disable "L".
44	Vss	sys	--	--	--	--	VSS			Connected to the system power supply (0V).
45	P20	I/O	I	Low	High	EXT_UP	SW_DATA0	KEY INPUT		Key matrix signal input.
46	P21	I/O	I	Low	High	EXT_UP	SW_DATA1	KEY INPUT		Key matrix signal input.
47	P22	I/O	I	Low	High	EXT_UP	SW_DATA2	KEY INPUT		Key matrix signal input.
48	P23	I/O	I	Low	High	EXT_UP	SW_DATA3	KEY INPUT		Key matrix signal input.
49	P24	I/O	I	Low	High	EXT_UP	SW_DATA4	KEY INPUT		Key matrix signal input.
50	P25	I/O	I	Low	High	EXT_UP	SW_DATA5	KEY INPUT		Key matrix signal input.
51	P26	I/O	I	Low	High	EXT_UP	SW_DATA6	KEY INPUT		Key matrix signal input.
52	P27	I/O	I	Low	High	EXT_UP	SW_DATA7	KEY INPUT		Key matrix signal input.
53	P50	I/O	O	--	High	--	SW_SCAN0	KEY SCAN		Key matrix signal output.
54	P51	I/O	O	--	High	--	SW_SCAN1	KEY SCAN		Key matrix signal output.
55	P52	I/O	O	--	High	--	SW_SCAN2	KEY SCAN		Key matrix signal output.
56	P53	I/O	O	--	High	--	SW_SCAN3	KEY SCAN		Key matrix signal output.
57	Vss	sys	--	--	--	--	VSS			Connected to the system power supply (0V).
58	P60	I/O	O	--	Low	--	SIF_ST	74HC4094	STR	Serial strobe data output for serial to parallel IC (74HC4094).
59	P61	I/O	O	--	Low	OPEN	SIF_LD	74HC165	LS/	Serial load data output for serial to parallel IC (74HC4094).
60	P62	I/O	O	--	Low	--	SIF_SI	74HC4094	DA	Serial data output for serial to parallel IC (74HC4094).
61	P67/Φ	--	--	--	--	OPEN	PAI			System clock output.
62	STBY/	sys	I	High	High	EXT_UP	STBY			Standby mode input for MPU. Normal mode "H".
63	RES/	sys	I	Low	High	EXT_UP	RES			System reset input for MPU. Reset "L".
64	NMI	sys	I	--	Low	EXT_DW	NMI			Not used.
65	Vss	sys	--	--	--	--	VSS			Connected to the system power supply (0V).
66	EXTAL	sys	I	--	--	--	EXTAL	X'tal		System clock input. Connected to 20MHz X'tal.
67	XTAL	sys	I	--	--	--	XTAL	X'tal		System clock output. Connected to 20MHz X'tal.
68	Vcc	sys	--	--	--	--	VCC			Connected to the system power supply (+5V).
69	P63	I/O	O	--	Low	--	SIF_CK	74HC4094	CK	Serial clock data output for ports expand IC.
70	P64	I/O	O	--	Low	--	DAC_DATA	PCM1710	MD/DM1	Serial data output for D/A converter IC.
71	P65	I/O	O	--	Low	--	DAC_CLK	PCM1710	MC/DM2	Serial clock data output for D/A converter IC.
72	P66	I/O	O	--	Low	--	DAC_LAT	PCM1710	ML/DSD	Serial latch data output for D/A converter IC.

PIN No.	PORT NAME	DEV ICE I/O	I/O	ACTIVE	INITIAL	PULL UP/DOWN	SIGNAL NAME	CONNECT DEVICE NAME	CONNECT DEVICE PORT NAME	FUNCTION
73	MD0	sys	I	--	High	EXT_UP	MD0			Mode select input for MPU. Mode7 "H".
74	MD1	sys	I	--	High	EXT_UP	MD1			Mode select input for MPU. Mode7 "H".
75	MD2	sys	I	--	High	EXT_UP	MD2			Mode select input for MPU. Mode7 "H", FLASH MPU program "L".
76	Avcc	sys	I	--	--	--	AVCC			Connected to the system power supply (+5V).
77	Vref	sys	I	--	--	--	VREF			AVCC.
78	P70 /AN0	I	I	Low	High	EXT_UP	SW_SP0	KEY INPUT		PLAY/PAUSE button input. Active "L".
79	P71/AN1	I	I	Low	High	EXT_UP	SW_SP1	KEY INPUT		CUE button input. Active "L".
80	P72/AN2	I	I	Low	High	EXT_UP	SW_FADER	KEY INPUT		FADER SW input. Active "L".
81	P73/AN3	I	I	--	High	EXT_UP	EEPROM_SO	AT25640	SO	Serial data input for EEPROM.
82	P74/AN4	I	I	--	Low	EXT_UP	TRAY_SW_OPEN	TRAY OPEN SW		Tray Open SW input. Open "L".
83	P75/AN5	I	I	--	Low	EXT_UP	TRAY_SW_CLOSE	TRAY CLOSE SW		Tray Close SW input. Close "L".
84	P76 /AN6/DA0	I	I	--	Low	UP/DW	SYS_MODEL_SEL0	RU09,RU05		(SEL0,SEL1): PMD330=(0,0), PMD331=(0,1) PMD340=(1,0)
85	P77 /AN7/DA1	I	I	--	Low	UP/DW	SYS_MODEL_SEL1	RU10,RU11		
86	Avss	sys	I	--	Low	--	AVSS			Connected to the system power supply (0V).
87	P80 /IRQ0/	I/O	I	--	Low	--	CXD_SCOR	CXD2585Q	SCOR	Detected from Sub code think signal. Detected "H".
88	P81 /IRQ1/	I/O	O	Low	High	EXT_UP	MONI_MUTE			Audio pre-mute control output. MUTE "L".
89	P82 /IRQ2/	I/O	O	High	Low	EXT_UP	TRAY_DRV_OPEN	LB1641	IN2	(IN1,IN2), (1,0) CW LOAD, (0,1) CCW UNLOAD, (0,0) or (1,1) STOP
90	P83 /IRQ3/	I/O	O	High	Low	EXT_UP	TRAY_DRV_CLOSE	LB1641	IN1	
91	P84	I/O	O	Low	Low	--	AUDIO_MUTE			Audio mute control output. MUTE "L".
92	Vss	sys	--	--	--	--	VSS			Connected to the system power supply (0V).
93	PA0 /TP0/TCLKA	I/O	I	Low	High	EXT_DW	ROT_DIAL_A	DIAL(+)		Rotary encoder input. CW (Forward) "H", CCW (Reverse) "L". 24puls/360°
94	PA1 /TP1/TCLKB	I/O	I	Low	High	EXT_DW	ROT_DIAL_B	DIAL(-)		
95	PA2 /TP2/TIOCA0	I/O	O	Low	High	--	RCS_MASK			IR signal mask SW.
96	PA3 /TP3/TIOCB0	I/O	O	--	Low	--	RCS_OUTPUT			RC5 signal output.
97	PA4 /TP4/TIOCA1	I/O	I	--	Low	--	RCS_INPUT	SPS-446-4		RC5 signal input.
98	PA5 /TP5/TIOCB1	I/O	O	High	High	EXT_UP	EEPROM_CS	AT25640	CS	Chip select output for EEPROM. Enable "H", Disable "L".
99	PA6 /TP6/TIOCA2	I/O	O	--	High	EXT_UP	EEPROM_SI	AT25640	SI	Serial data output for EEPROM.
100	PA7 /TP7/TIOCB2	I/O	O	--	High	EXT_UP	EEPROM_CLK	AT25640	SCK	Serial clock data output for EEPROM.

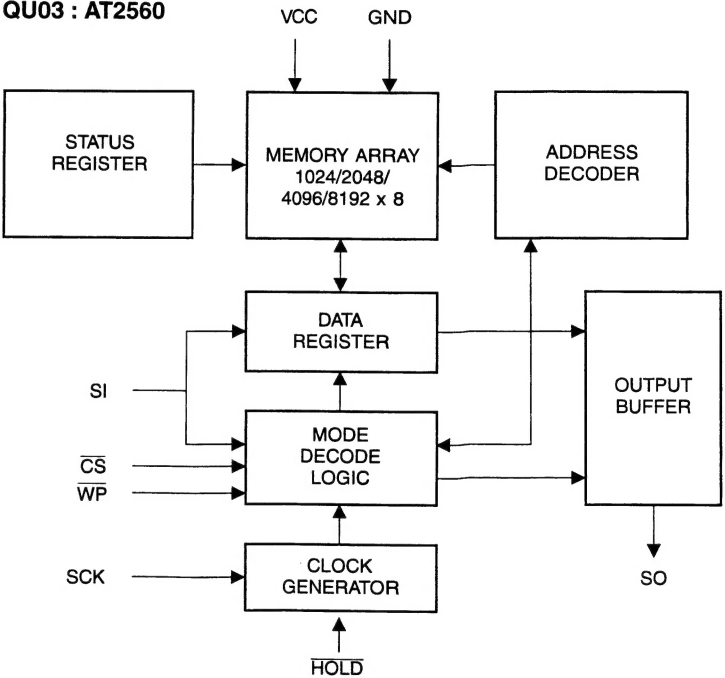
QY01 : HD66712



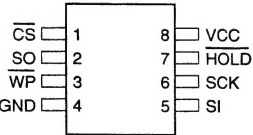
Q201/Q202 : TDA7073A

PIN	SYMBOL	DESCRIPTION
1	IN1-	negative input 1
2	IN1+	positive input 1
3	n.c.	not connected
4	n.c.	not connected
5	VP	positive supply voltage
6	IN2+	positive input 2
7	IN2-	negative input 2
8	n.c.	not connected
9	OUT2+	positive output 2
10	GND2	ground 2
11	n.c.	not connected
12	OUT2-	negative output 2
13	OUT1-	negative output 1
14	GND1	ground 1
15	n.c.	not connected
16	OUT1+	positive output 1

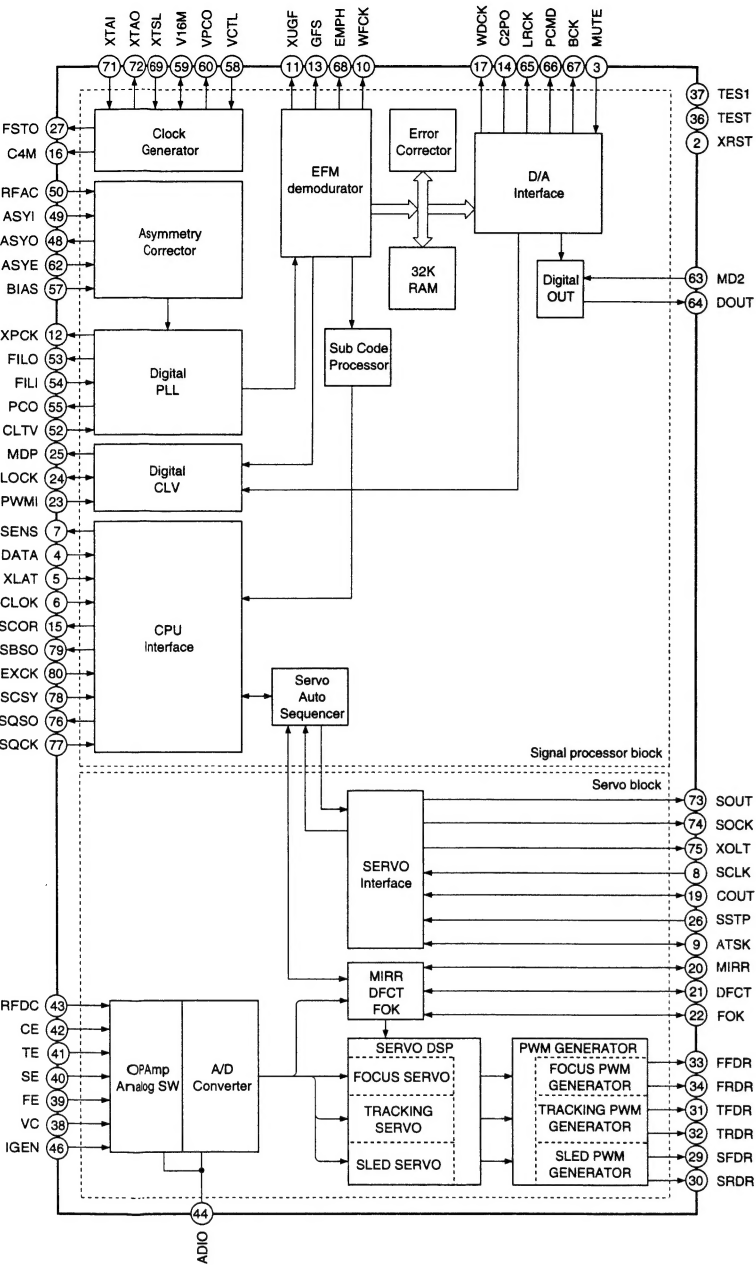
QU03 : AT2560



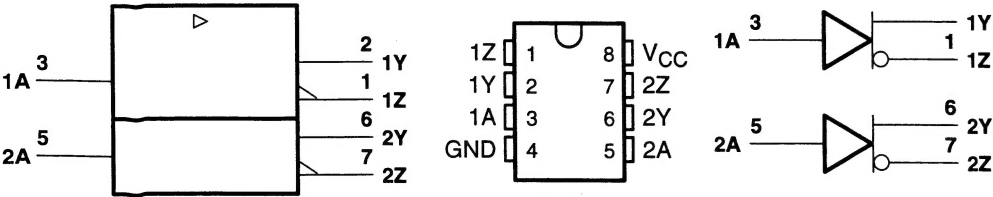
Pin Name	Function
CS	Chip Select
SCK	Serial Data Clock
SI	Serial Data Input
SO	Serial Data Output
GND	Ground
VCC	Power Supply
WP	Write Protect
HOLD	Suspends Serial Input
NC	No Connect
DC	Don't Connect



QD01 : CXD2585Q



QT52 : SN75158



Pin No.	Symbol	I/O	Description
1	DVDD0	-	Power supply.
2	XRST	I	System reset. Reset when low.
3	MUTE	I	Mute input (low: off, high: on)
4	DATA	I	Serial data input from CPU.
5	XLAT	I	Latch input from CPU. Serial data is latched at the falling edge.
6	CLOCK	I	Serial data transfer clock input from CPU.
7	SENS	O 1, 0	SENS output to CPU.
8	SCLK	I	SENS serial data readout clock input.
9	ATSK	I/O 1, 0	Anti-shock input/output.
10	WFCK	O 1, 0	WFCK output.
11	XUGF	O 1, 0	XUGF output. MNT0 or RFCK is output by switching with the command.
12	XPCK	O 1, 0	XPCK output. MNT1 is output by switching with the command.
13	GFS	O 1, 0	GFS output. MNT2 or XROF is output by switching with the command.
14	C2PO	O 1, 0	C2P0 output. MNT3 or GTOP is output by switching with the command.
15	SCOR	O 1, 0	Outputs a high signal when either subcode sync SO or S1 is detected.
16	C4M	O 1, 0	4.2336MHz output. 1/4 frequency division output for V16M in CAV-W mode or variable pitch mode.
17	WDCK	O 1, 0	Word clock output. f = 2Fs. GRSCOR is output by the command switching.
18	DVss0	- -	Digital GND.
19	COUT	I/O 1, 0	Track count ,signal I/O.
20	MIRR	I/O 1, 0	Mirror signal I/O.
21	DFCT	I/O 1, 0	Detect signal I/O.
22	FOK	I/O 1, 0	Focus OK signal I/O.
23	PWMI	I	Spindle motor external control input.
24	LOCK	I/O 1, 0	GFS is sampled at 460Hz; when GFS is high, this pin outputs a high signal. If GFS is low eight consecutive samples, this pin outputs low. Input when LKIN=1.
25	MDP	O 1, Z, 0	Spindle motor servo control output.
26	SSTP	I	Disc innermost track detection signal input.
27	FSTO	O 1, 0	2/3 frequency division output for XTAL pin.
28	DVDD1	- -	Digital power supply.
29	SFDR	O 1, 0	Sled drive output.
30	SRDR	O 1, 0	Sled drive output.
31	TFDR	O 1, 0	Tracking drive output.
32	TRDR	O 1, 0	Tracking drive output.
33	FFDR	O 1, 0	Focus drive output.
34	FRDR	O 1, 0	Focus drive output.
35	DVss1	- -	Digital GND.
36	TEST	I	Test. Normally, GND.

Pin NO.	Symbol	I/O	Description
37	TES1	I	Test. Normally, GND.
38	VC	I	Center voltage input.
39	FE	I	Focus error signal input.
40	SE	I	Sled error signal input.
41	TE	I	Tracking error signal input.
42	CE	I	Center servo analog input.
43	RFDC	I	RF signal input.
44	ADIO	O Analog	Test. No connected.
45	AVss0	- -	Analog GND.
46	IGEN	I	Constant current input for operational amplifier.
47	AVDD0		Analog power supply.
48	ASYO	O 1, 0	EFM full-swing output. (low = Vss, high = VDD)
49	ASYI	I	Asymmetry comparator voltage input.
50	RFAC	I	EFM signal input.
51	AVss1	- -	Analog GND.
52	CLTV	I	Multiplier VCO1 control voltage input.
53	FILO	O Analog	Master PLL filter output (slave = digital PLL).
54	FILI	I	Master PLL filter input.
55	PCO	O 1, Z, 0	Master PLL charge pump output.
56	AVDD1	- -	Analog power supply.
57	BIAS	I	Asymmetry circuit constant current input.
58	VCTL	I	Wide-band EFM PLL VC02 control voltage input.
59	V16M	I/O 1, 0	Wide-band EFM PLL VC02 oscillation output. Serves as wide-band EFM PLL clock input by switching with the command.
60	VPCO	O 1, Z, 0	Wide-band EFM PLL charge pump output.
61	DVDD2	- -	Digital power supply.
62	ASYE	I	Asymmetry circuit on/off (low = off, high = on).
63	MD2	I	Digital Out on/off control (low = off, high = on).
64	DOUT	O 1, 0	Digital Out output.
65	LRCK	O 1, 0	D/A interface. LR clock output. f = Fs
66	PCMD	O 1, 0	D/A interface. Serial data output (two's complement, MSB first).
67	BCK	O 1, 0	D/A interface. Bit clock output.
68	EMPH	O 1, 0	Outputs a high signal when the playback disc has emphasis, and a low signal when there is no emphasis.
69	XTSL	I	Crystal selection input. Low when the crystal is 16.9344MHz; high when it is 33.8688MHZ.
70	DVss2	- -	Digital GND.
71	XTAL	I	Crystal oscillation circuit input. When the master clock is input externally, input it from this pin.
72	XTAO	O	Crystal oscillation circuit output.

Pin NO.	Symbol	I/O	Description
73	SOUT	O 1, 0	Serial data output in servo block.
74	SOCK	O 1, 0	Serial data readout clock output in servo block.
75	XOLT	O 1, 0	Serial data latch output in servo block.
76	SQSO	O 1, 0	Sub-Q 80-bit, PCM peak or level data outputs. CD TEXT data output t.
77	SQCK	I	SQSO readout clock input.
78	SCSY	I	GRSCOR resynchronization input.
79	SBSO	O 1, 0	Sub-Q P to W serial output.
80	EXCK	I	SBSO readout clock input.

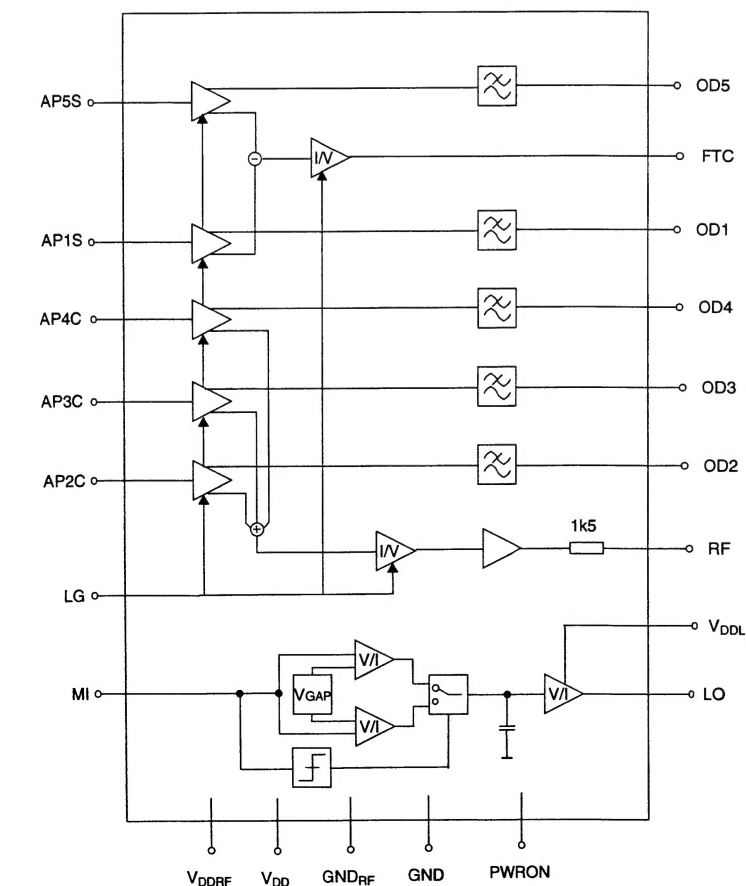
- Notes)
- * PCMD is a MSB first, two's complement output.
 - * GTOP is used to monitor the frame sync protection status. (High: sync protection window released.)
 - * XUGF is the frame sync obtained from the EFM signal, and is negative pulse. It is the signal before sync protection.
 - * XPCK is the inverse of the EFM PLL clock. The PLL is designed so that the falling edge and the EFM signal transition point coincide.
 - * The GFS signal goes high when the frame sync and the insertion protection timing match.
 - * RFCK is derived from the crystal accuracy, and has a cycle of 136us. (during normal speed)
 - * C2PO represents the data error status.
 - * XROF is generated when the 32K RAM exceeds the +-28F jitter margin.

The block diagram illustrates the internal architecture of the AD7714 ADC. Key components include:

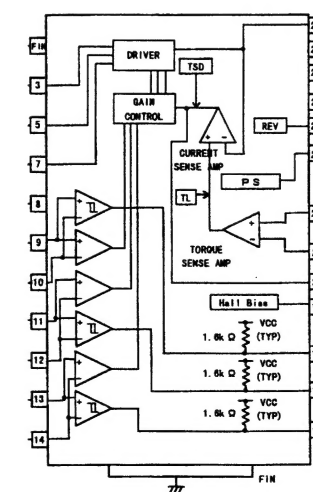
- Input Interface:** Receives LRCIN (pin 1) and DIN (pin 2).
- Timing Control:** Receives BCKIN (pin 3) and CLKO (pin 4).
- Digital Filter and Mode Control:** Receives XT1 (pin 5) and XTO (pin 6).
- Noise Shaper:** Receives DGND (pin 7) and provides output to the DACs.
- 5-Level $\Delta\Sigma$ DAC Right:** Receives V_{DD} (pin 8) and V_{CC2R} (pin 9).
- 5-Level $\Delta\Sigma$ DAC Left:** Receives V_{DD} (pin 21) and V_{CC2L} (pin 20).
- Low-Pass Filter-Left:** Receives AGND2L (pin 19).
- Output Amplifier Left:** Receives EXT1L (pin 18) and EXT2L (pin 17).
- Output:** V_{OUTL} (pin 16) and V_{CC1} (pin 15).

The diagram also shows the connection of AGND1 (pin 14) to the input and output stages, and the connection of ML/DSD (pin 28) to the input interface.

Q101 : TZA1022



Q251 : BA6856FP



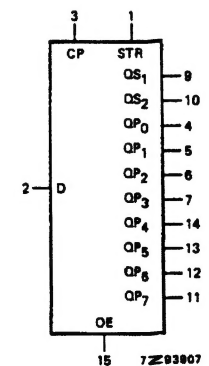
PIN No	端子 名 /Pin Name	機 能 /Function
1	N.C.	N.C.
2	N.C.	N.C.
3	A ₃	出力端子/Output3 for motor
4	N.C.	N.C.
5	A ₂	出力端子/Output2 for motor
6	N.C.	N.C.
7	A ₁	出力端子/Output1 for motor
8	GND	GND端子/GND
9	H ₁ ⁺	ホール信号入力端子/Hall input Amp1. positive input
10	H ₁ ⁻	ホール信号入力端子/Hall input Amp1. negative input
11	H ₂ ⁺	ホール信号入力端子/Hall input Amp2. positive input
12	H ₂ ⁻	ホール信号入力端子/Hall input Amp2. negative input
13	H ₃ ⁺	ホール信号入力端子/Hall input Amp3. positive input
14	H ₃ ⁻	ホール信号入力端子/Hall input Amp3. negative input
15	N.C.	N.C.
16	FG3	FG信号出力端子/FG3 signal output terminal
17	FG2	FG信号出力端子/FG2 signal output terminal
18	FG1	FG信号出力端子/FG1 signal output terminal
19	V _{in}	ホールバイアス端子/Hall Bias
20	C _{inf}	位相補償用コンデンサ接続端子 /Capacitor connection pin for phase compensation
21	E _{CR}	出力電圧制御基準端子 /Torque control standard voltage input terminal
22	E _c	出力電圧制御端子/Torque control voltage input terminal
23	PS	パワーセーブ端子/ POWER SAVE switch
24	R _{rev}	逆転端子/Reverse terminal
25	V _{CC}	電源端子/Power supply for signal division
26	V _{SS2}	12V用電源端子/Power supply2 for driver
27	V _{SS1}	モータ電源端子/Power supply for driver
28	R _{fr}	出力電流検出用抵抗接続端子 /Power supply for driver division
FIN	FIN	GND

SCK
XLT
XSOE
SDTI
SDTO



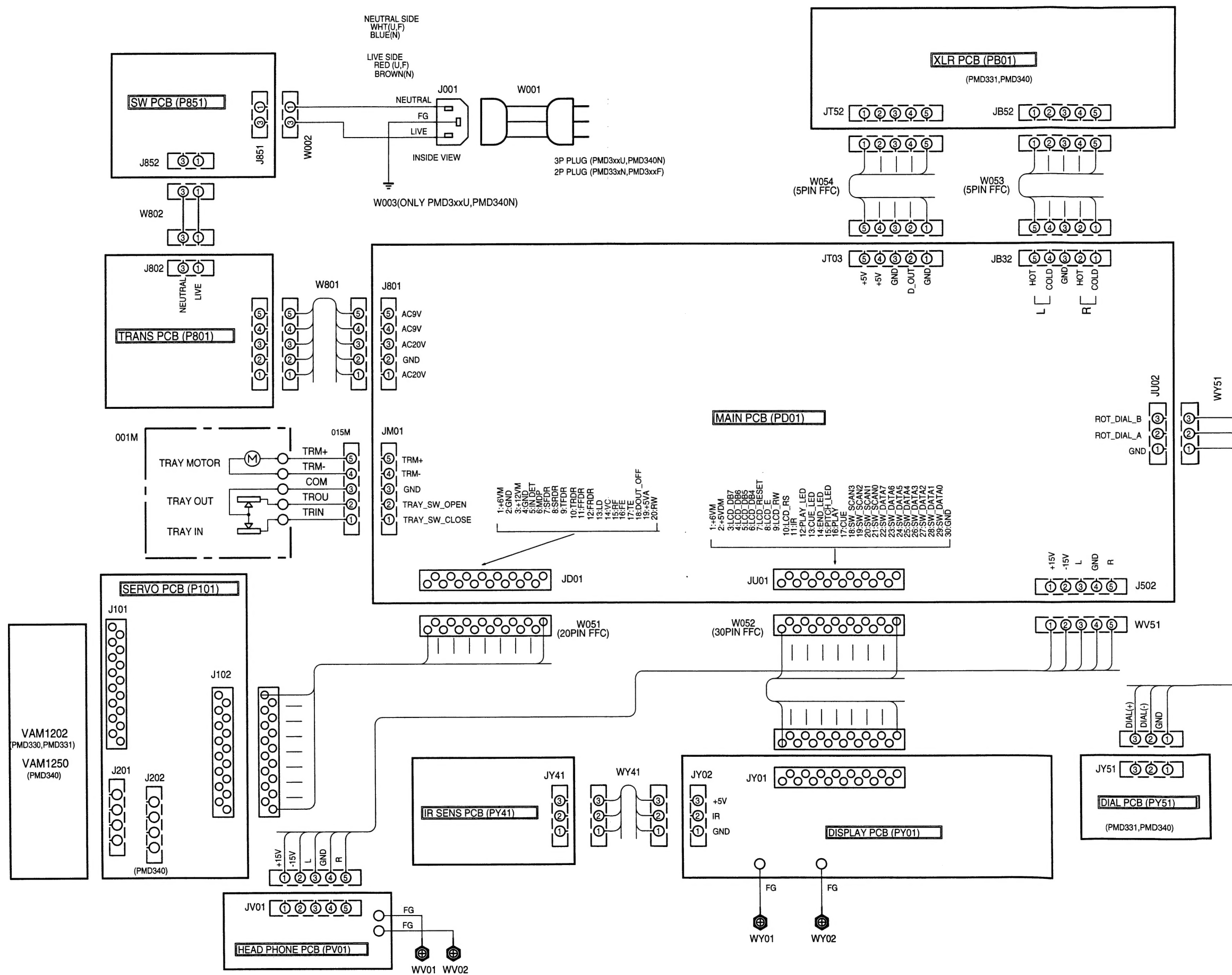
PIN NUMBER	SYMBOL	FUNCTION
1	$\overline{\text{PL}}$	Asynchronous parallel load input (active LOW)
2	CP	Clock input (LOW to HIGH, edge-triggered)
7	$\overline{\text{Q}}_7$	Complementary output from the last stage
8	GND	Ground (0 V)
9	Q_7	Serial output from last stage
10	D_S	Serial data input
11, 12, 13, 14, 3, 4, 5, 6	D_0 to D_7	Parallel data inputs
15	$\overline{\text{CE}}$	Clock enable input (active LOW)
16	V_{CC}	Positive supply voltage

PIN NO.	SYMBOL	NAME AND FUNCTION
1	STR	strobe input
2	D	serial input
3	CP	clock input
4, 5, 6, 7, 14, 13, 12, 11	QP ₀ to QP ₇	parallel outputs
8	GND	ground (0 V)
9, 10	QS ₁ , Q S ₂	serial outputs
15	OE	output enable input
16	V _{CC}	positive supply voltage

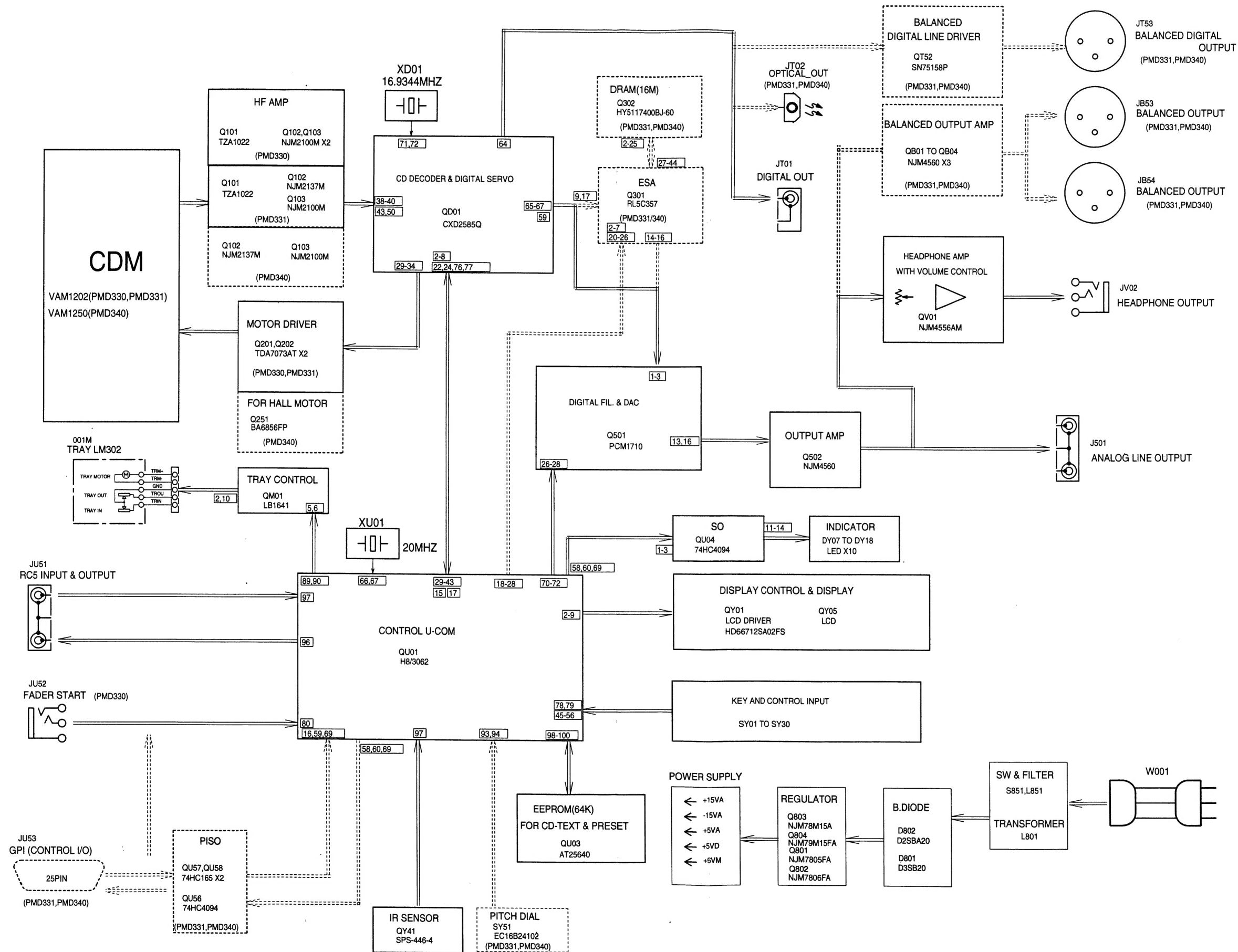


Pin	PIN NAME	I/O	FUNCTION	LOGIC	
				H	L
1	VCC	--	POWER SUPPLY	--	--
2	XQOK	lpu	SUB CODE-Q OK SIGNAL FROM CPU	--	OK
3	XWRE	lpu	WRITE ENABLE SIGNAL FROM CPU	--	PERMIT
4	XEMP	O	READ INHIBIT SIGNAL TO CPU	--	INHIBIT
5	XWIH	O	WRITE INHIBIT SIGNAL TO CPU	--	INHIBIT
6	XCAS2	O	DRAM CAS2 CONTROL	--	--
7	CHDT	O	DATA COMPARATIVE MONITOR SIGNAL OUTPUT TO CPU	COMPARE	--
8	A10	O	DRAM ADDRESS 10	--	--
9	CLK	I	16.9344MHz CLOCK INPUT	--	--
10	GND	--	GROUND	--	--
11	DAT1	lcs	AUDIO DATA INPUT	--	--
12	LRCI	lcs	AUDIO L/R CLOCK INPUT	Lch	Rch
13	BCKI	lcs	AUDIO BIT CLOCK INPUT	--	--
14	BCKO	O	AUDIO BIT CLOCK OUTPUT	--	--
15	LRCO	O	AUDIO L/R CLOCK OUTPUT	Lch	Rch
16	DATO	O	AUDIO DATA OUTPUT	--	--
17	XROF	lcs	RAM OVERFLOW FROM SIGNAL PROCESSOR IC	--	OVER FLOW
18	RFCK	lpu	FRAME CLOCK FROM SIGNAL PROCESSOR IC, DERIVED FROM THE CRYSTAL ACCURACY	--	--
19	SCOR	I	SUB CODE SYNC DETECT SIGNAL FROM SIGNAL PROCESSOR IC	--	--
20	XRST	lcs	SYSTEM RESET	--	RESET
21	SDTO	O	SERIAL DATA OUTPUT TO CPU	--	--
22	XSOE	lpu	SERIAL DATA OUTPUT PERMISSION SIGNAL INPUT FROM CPU	--	PERMIT
23	TEST	lpd	TEST MODE	--	--
24	XLT	lcs	LATCH INPUT FROM CPU	--	--
25	SDTI	lcs	SERIAL DATA INPUT FROM CPU	--	--
26	SCK	lcs	SERIAL DATA TRANSFER CLOCK INPUT FROM CPU	--	--
27	XCAS1/XOE	O	DRAM CAS1/OE CONTROL	--	--
28	XCAS0	O	DRAM CAS0 CONTROL	--	--
29	D2	I/O	DRAM DATA 2	--	--
30	D3	I/O	DRAM DATA 3	--	--
31	D0	I/O	DRAM DATA 0	--	--
32	D1	I/O	DRAM DATA 1	--	--
33	XWE	O	DRAM WE CONTROL	--	--
34	XRAS	O	DRAM RAS CONTROL	--	--
35	A9	O	DRAM ADDRESS 9		
36	A8	O	DRAM ADDRESS 8		
37	A7	O	DRAM ADDRESS 7		
38	A6	O	DRAM ADDRESS 6		
39	A5	O	DRAM ADDRESS 5		
40	A4	O	DRAM ADDRESS 4		
41	A0	O	DRAM ADDRESS 0		
42	A1	O	DRAM ADDRESS 1		
43	A2	O	DRAM ADDRESS 2		
44	A3	O	DRAM ADDRESS 3		

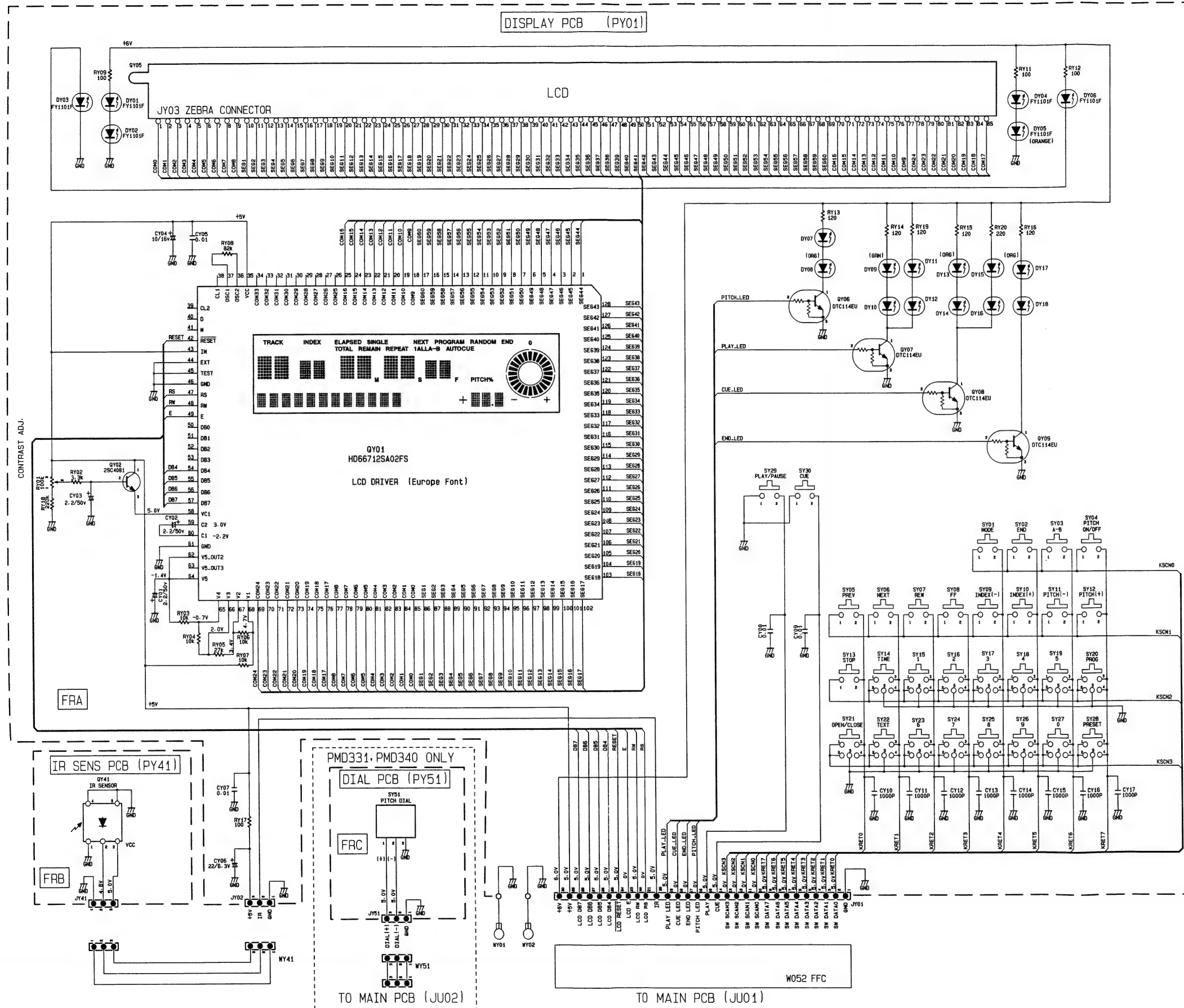
6. WIRING DIAGRAM



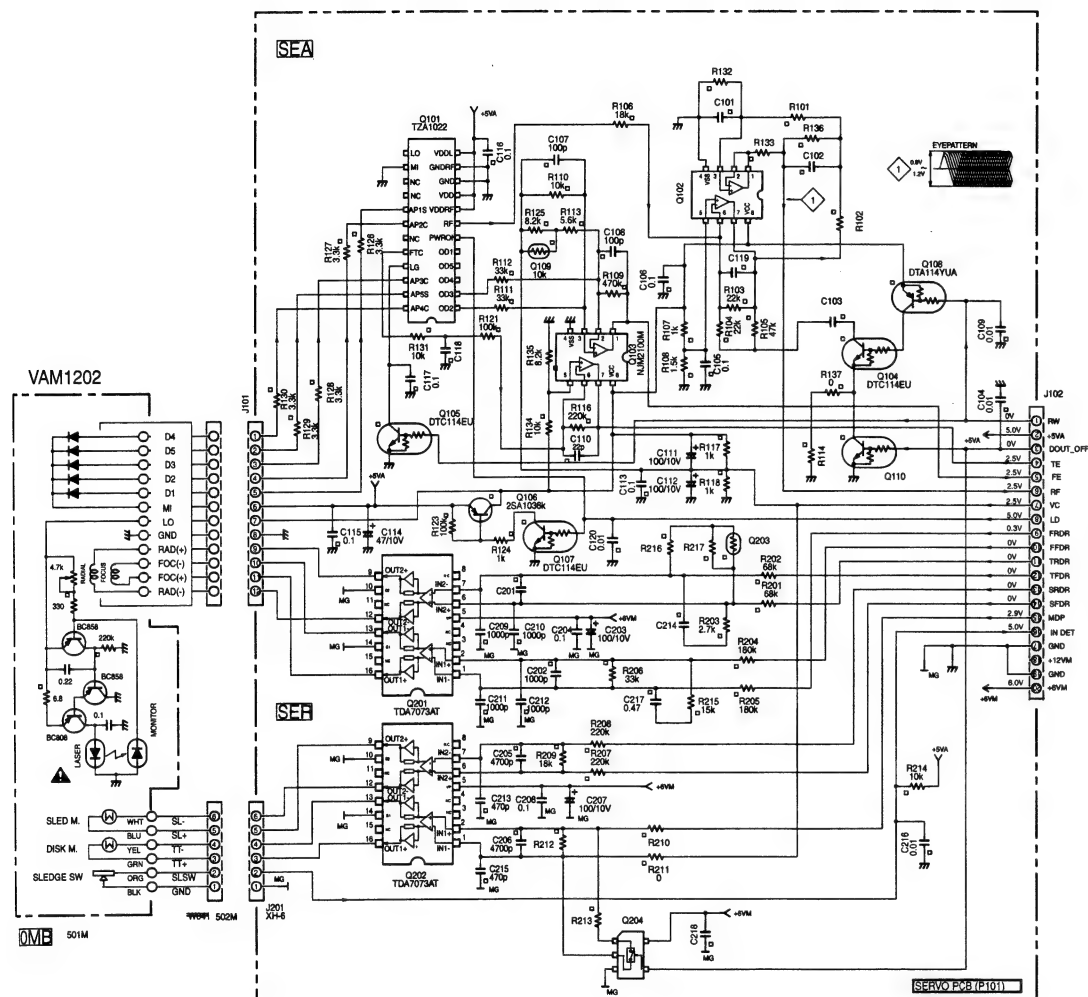
7. BLOCK DIAGRAM



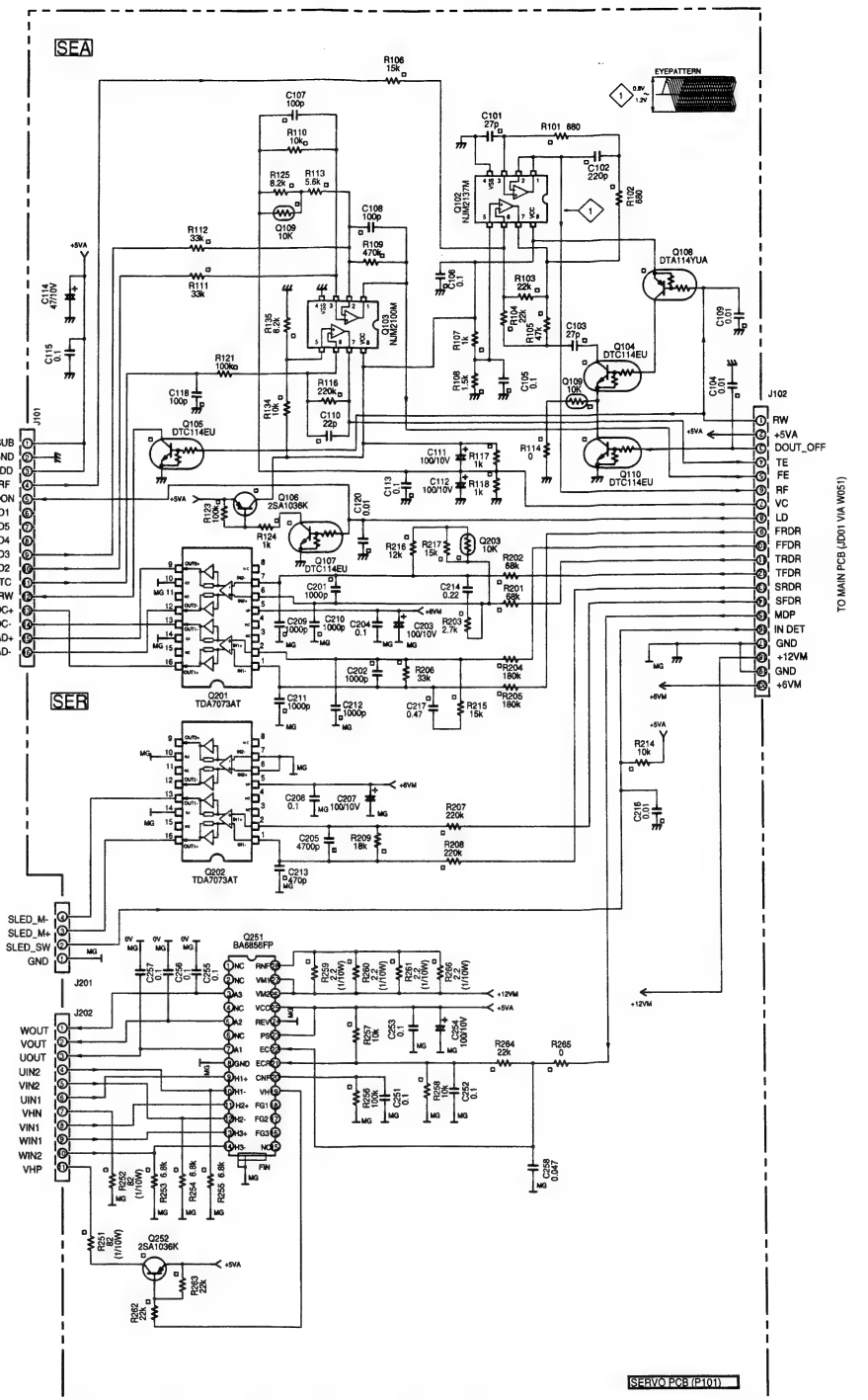
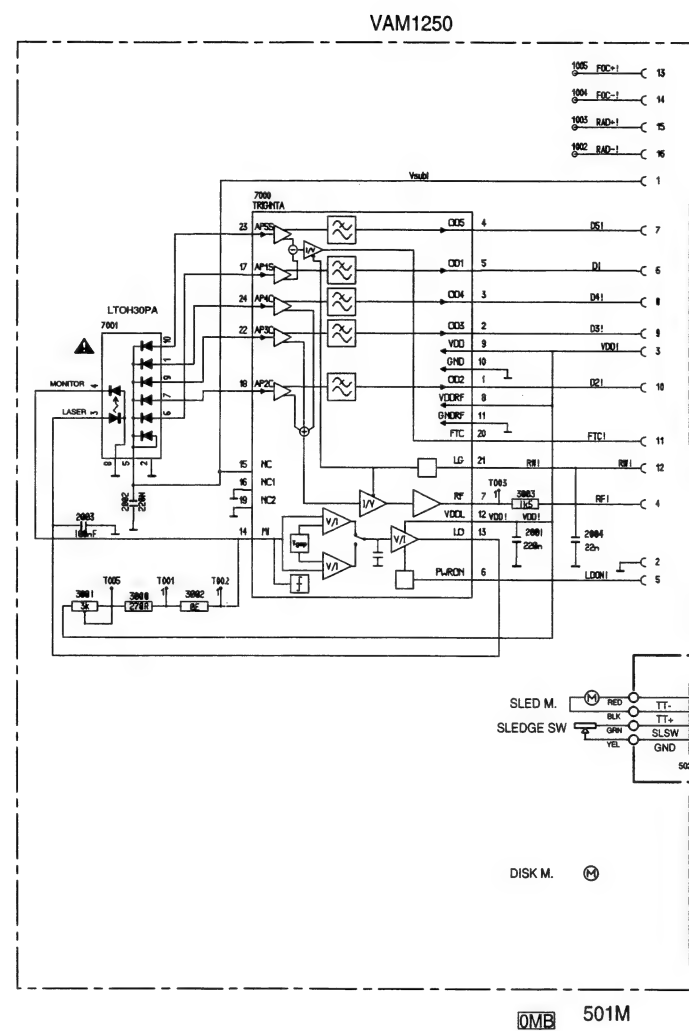
8. SCHEMATIC DIAGRAM



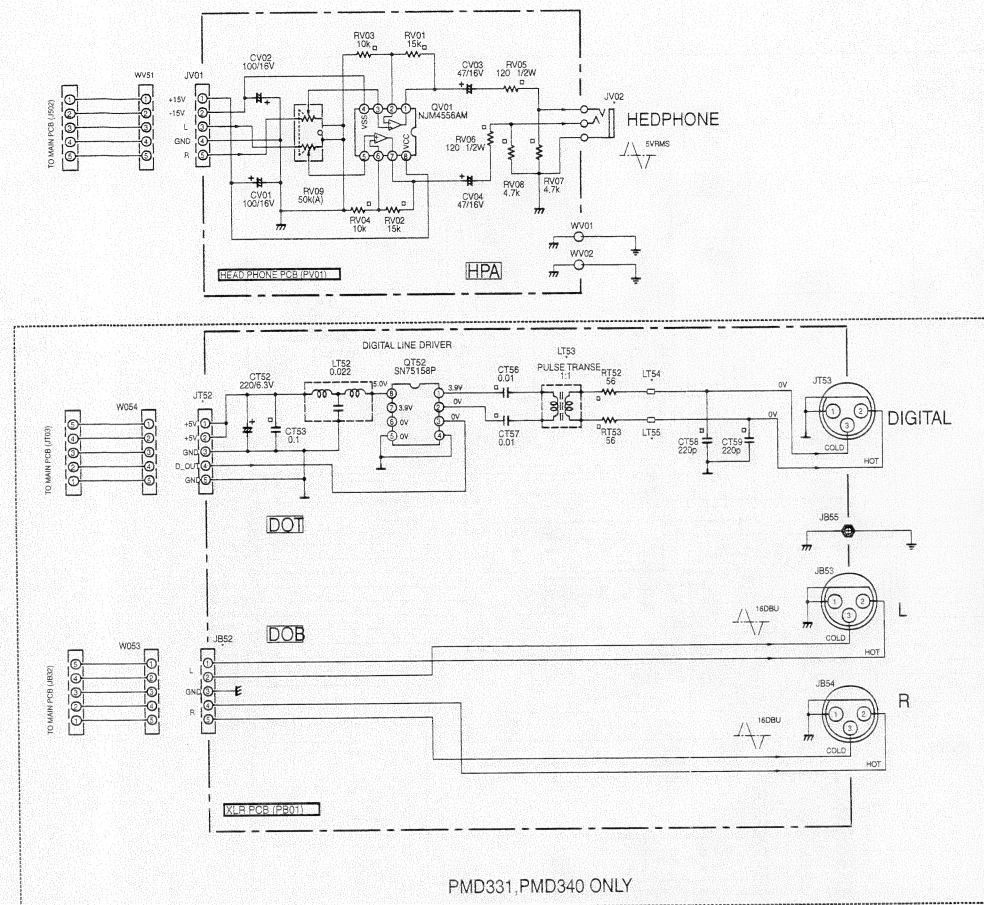
PMD330, PMD331 ONLY



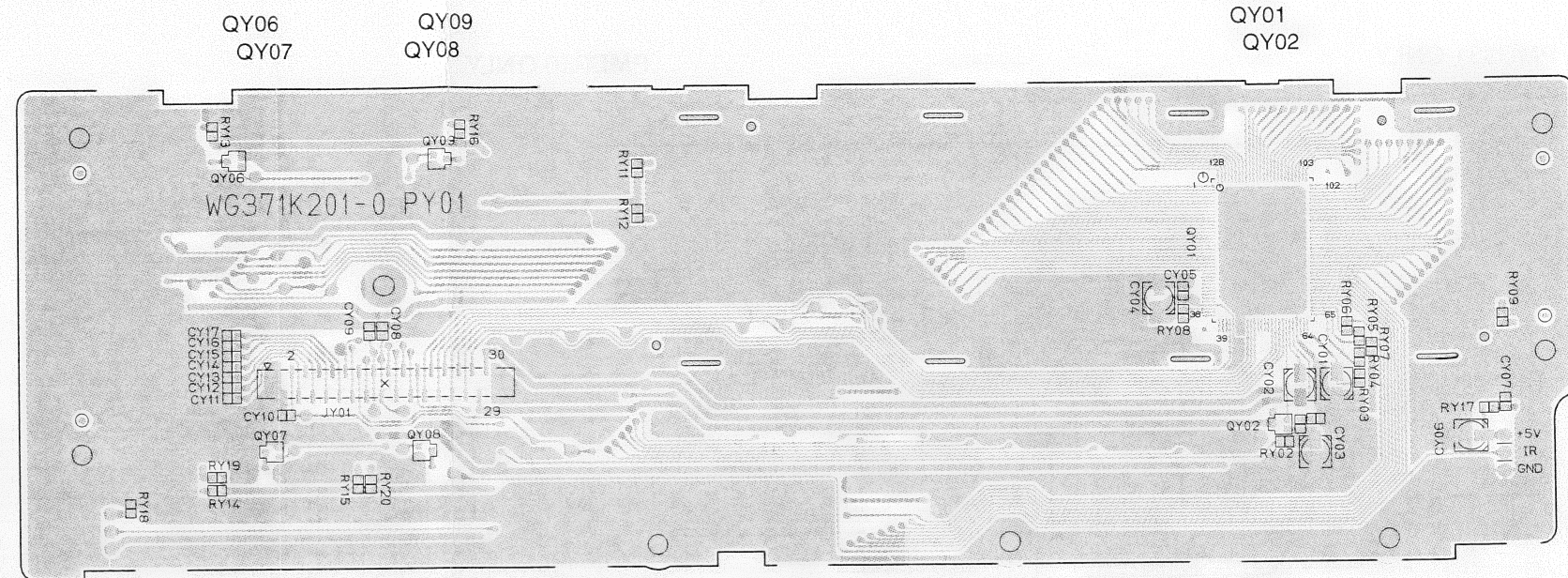
PMD340 ONLY



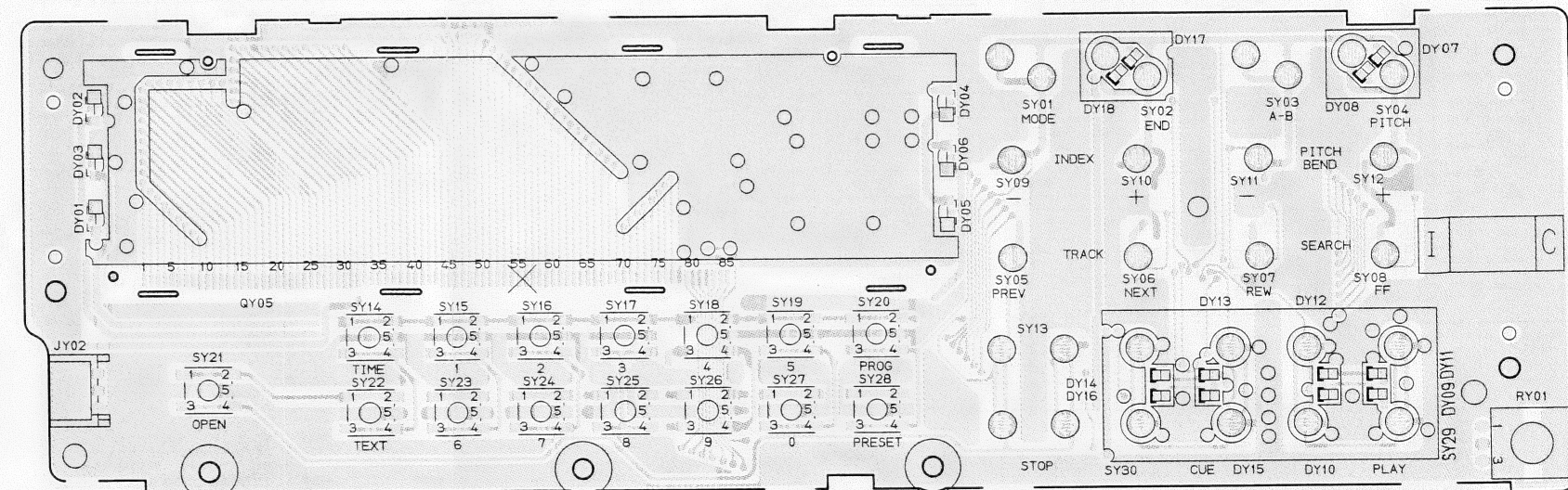
9. PARTS LOCATION



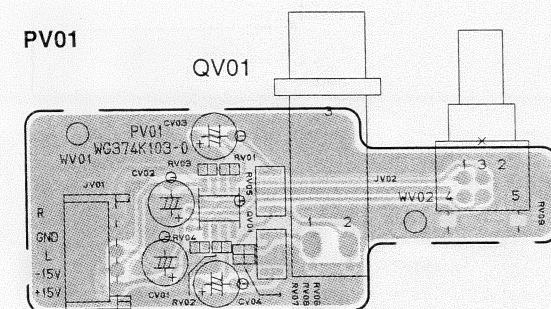
PY01



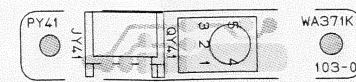
PY01



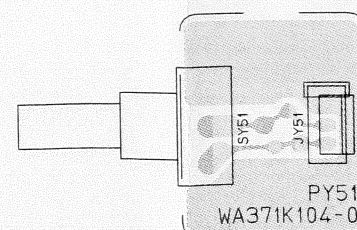
PY41



QY41

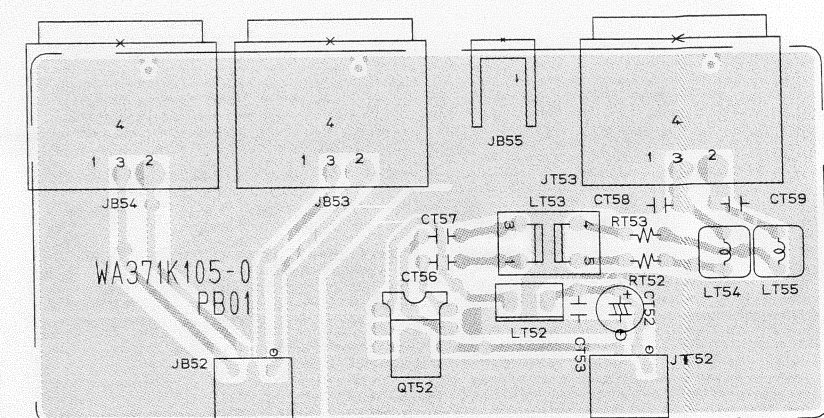


PY51



PB01

QT52



PD01

Q301 Q302
Q501 Q541
Q502

QB03 QB02
QB01

QB04

QU41 QU42

QU91

QU04

QU01

QD01

QU03
QU52 QU51

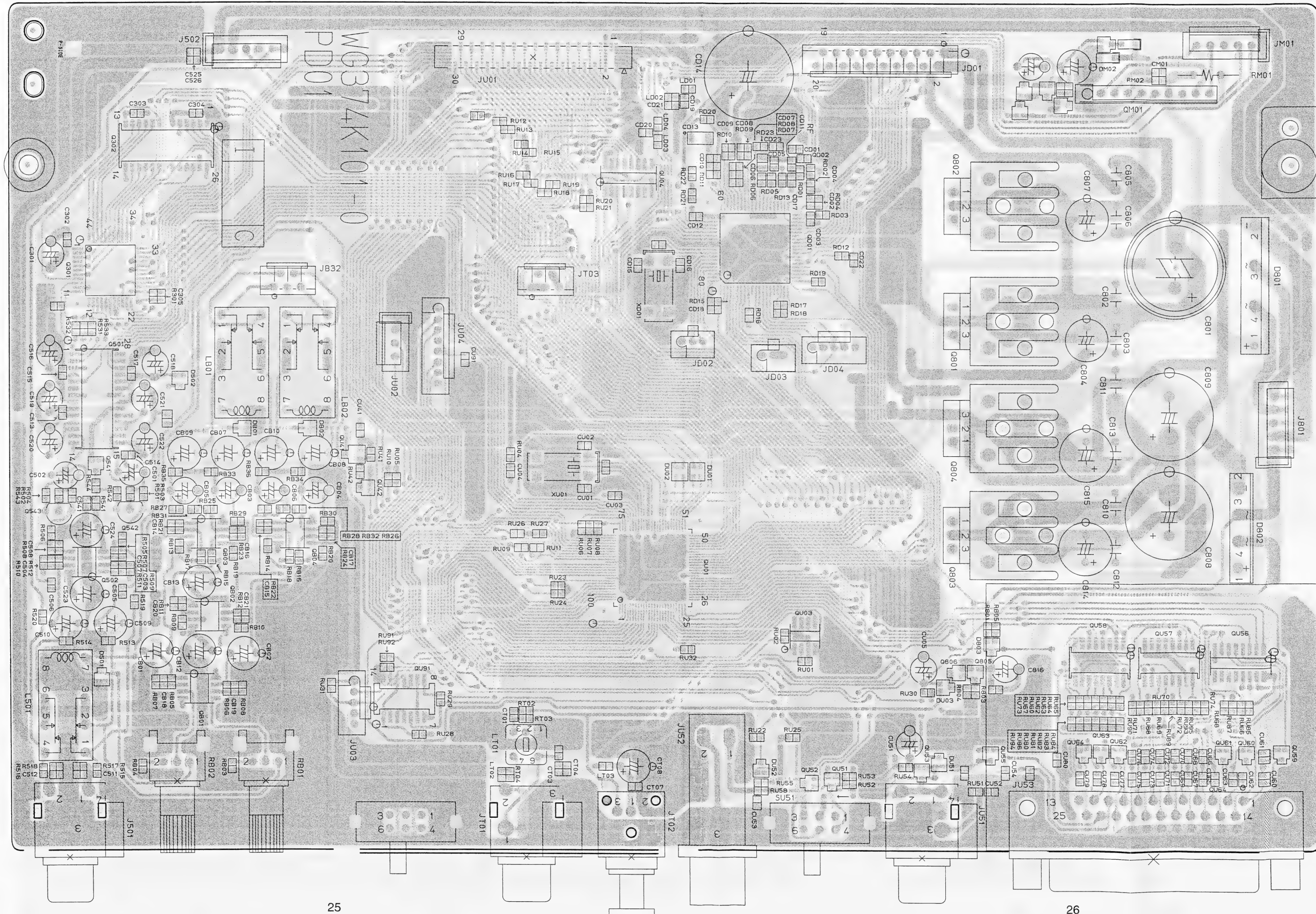
Q802 Q801
Q804

Q803
Q806 Q805

QM01

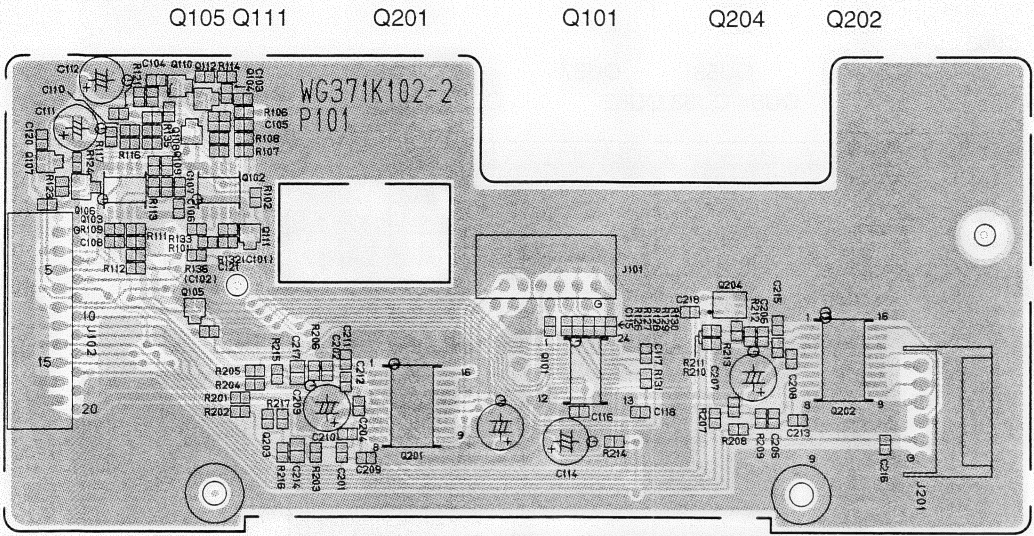
QU58 QU57
QU64 QU63 QU62

QU56
Q61 QU60 QU59



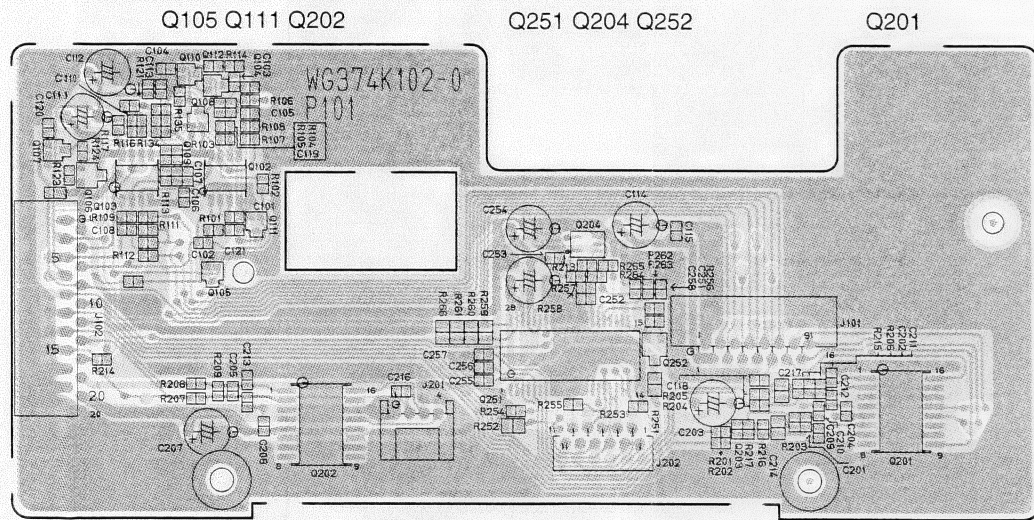
P101 (PMD330, PMD331)

Q110 Q108 Q112
Q107 Q106 Q103 Q102



P101 (PMD340)

Q110 Q108 Q112
Q107 Q106 Q103 Q102



11. TECHNICAL DESCRIPTION

1. RC5 Code

This product is able to communicate to the other MARANTZ products with the RCA Pin cable.

1. RC5コード

RCA Pinコードを介して他の機器と通信できる。

	Command Name	Code	Decode			Binary		
			SYS	COM	DATA	START	SYS	COM DATA
INPUT	Play	2053	20	53		11	10100	110101
	Pause	2048	20	48		11	10100	110000
	Cue	2059-10	20	59	10	11	10100	111011 1010
	Stop	2054	20	54		11	10100	110110
	FF	2052	20	52		11	10100	110100
	FR(REW)	2050	20	50		11	10100	110010
	Index+	2034	20	34		11	10100	100010
	Index-	2035	20	35		11	10100	100011
	Next	2032	20	32		11	10100	100000
	Previous	2033	20	33		11	10100	100001
	Pitch+	2038	20	38		11	10100	100110
	Pitch-	2039	20	39		11	10100	100111
	Pitch Bend+ ★ 2 ★ 3	2038-10	20	38	10	11	10100	100110 1010
	Pitch Bend- ★ 2 ★ 3	2039-10	20	39	10	11	10100	100111 1010
	A-B	2059	20	59		11	10111	111011
	Program	2041	20	41		11	10100	101001
	Pitch On/Off	2037	20	37		11	1010	100101
	Open/Close	2045	20	45		11	10100	101101
	Time	2011	20	11		11	10100	1011
	Mode	2036-10	20	36	10	11	10100	100100 1010
	Preset	2041-12	20	41	12	11	10100	101001 1100
	END monitor	2043-10	20	43	10	11	10100	101011 1010
	CD-TEXT	2088	20	88		10	10100	11000
	0	2000	20	00		11	10100	0
	1	2001	20	01		11	10100	1
	2	2002	20	02		11	10100	10
	3	2003	20	03		11	10100	11
	4	2004	20	04		11	10100	100
	5	2005	20	05		11	10100	101
	6	2006	20	06		11	10100	110
	7	2007	20	07		11	10100	111
	8	2008	20	08		11	10100	1000
	9	2009	20	09		11	10100	1001
	SERVICE ★1	166363	16	63	63	11	10000	111111 111111
OUTPUT	Connect	1856	18	56		11	10010	111000
	Disconnect	1857	18	57		11	10010	111001

*1 The service code is available during STOP mode only.

*2 The Pitch Bend+ and Pitch Bend- are not available with the digital out on.

*3 The Pitch Bend+ and Pitch Bend- are not available on PMD330.

*1 サービスコードは STOP 状態の時のみ受け付ける。

*2 Pitch Bend+、Pitch Bend- はデジタルアウト On 時には受け付けない。

*3 表内の Pitch Bend+、Pitch Bend- は PMD330 では No Action とする。

5. GPI code

The GPI code is input from external controller with D-Sub 25 Pin connector.

2. GPI コード

D-Sub25Pinコネクタで外部のコントローラーより入力される。

Pin	Name	I/O	Active
1	PLAY TALLY	O	Low
2	PAUSE TALLY	O	Low
3	CUE TALLY	O	Low
4	STOP	I	Low
5	FR	I	Low
6	INDEX-	I	Low
7	PREVIOUS	I	Low
8	PITCH+	I	Low
9	PITCH ON/OFF	I	Low
10	FADER(NORMAL)	I	Low
11	INDEX #2/#3 TALLY	O	Low
12	+5V	-	---
13	FG COMMON	-	---
14	PLAY	I	Low
15	PAUSE	I	Low
16	CUE	I	Low
17	FF	I	Low
18	INDEX+	I	Low
19	NEXT	I	Low
20	END	I	Low
21	PITCH-	I	Low
22	FADER TALLY	O	Low
23	FADER(INVERT)	I	High
24	END TALLY	O	Low
25	TALLY COMMON	-	---

* The fader start is on during PLAY, and off during PAUSE.

* The index is output by pulse signal.

When the index #2 is selected, the pulse signal of 200ms is output at the top of index #2.

1 1 1 1 2 2 2 2 2 2

200ms

When the index #3 is selected, the pulse signal of 200ms is output at the top of index #3.

2 2 2 2 3 3 3 3 3 3

200ms

3. Double speed Reading

The disc (spindle) motor of PMD331/340 rotates at double speed for the Instant start & Anti-shock (shockproof) behavior function.

The data that is read out at double speed from a CD is put into the shockproof memory control & DRAM.

The data that is in the shockproof memory is forwarded to the DAC and is played back at normal speed.

When it is set Digital Out to "ON" on the preset menu, the disc (spindle) motor rotates at normal speed, and the data is read at normal speed.

Therefore, Digital output is always outputted at normal speed.

PMD330 doesn't have the shockproof memory control. Therefore the disc (spindle) motor of PMD330 always rotates at normal speed.

※ Fader Start は、Play で On し、Pause 状態で Off となる。

※ Index はパルスで出力する。

Index #2 選択時、Index #2 の頭で 200ms のパルスを出力する。

1 1 1 1 2 2 2 2 2 2

200ms

Index #3 選択時、Index #3 の頭で 200ms のパルスを出力する。

2 2 2 2 3 3 3 3 3 3

200ms

3. 2倍速について

PMD331/340は、Instant start & Anti-shock (shokproof) behavior 機能の為に、2倍速で Disc (Spindle) Motor を回転させています。

CDから2倍速にて読み出されたデータは、Shokproof memory control & DRAMにいったんメモリーします。

ここでメモリーされたデータは1倍速にて Shokproof memory control より DACに転送され通常のスピードで再生されます。

但し、Preset Menuにて Digital Out "ON" に設定した場合は、1倍速で Disk (Spindle) Motor は回転し1倍速でデーターの読み出しが行われます。

よって、Digital 出力は常に1倍速で出力されます。

PMD330は Shokproof memory control を搭載していないので常に Disc (Spindle) Motor は1倍速にて回転します。

POS. NO	VERS. COLOR	PART NO. (FOR PCS)	DESCRIPTION	PART NO. (MJI)
P101-SERVO CIRCUIT BOARD				
P101-CAPACITORS				
C101	331/340	4822 126 11669	CER. CHIP 27pF ±5%	DD95270300
C102	331/340	4822 126 13883	CER. CHIP 220pF ±5% CG 50V	DD95221300
C103		4822 126 11669	CER. CHIP 27pF ±5%	DD95270300
C104		4822 126 14417	CER. CHIP 0.01μF ±10% 50V	DK96103300
C105		4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C106		4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C107		4822 122 31765	CER. CHIP 100pF ±5% CG 50V	DD95101300
C108		4822 122 31765	CER. CHIP 100pF ±5% CG50V	DD95101300
C109		4822 126 14417	CER. CHIP 0.01μF ±10% 50V	DK96103300
C110		4822 122 33761	CER. CHIP 22pF ±5% CG 50V	DD95220300
C111			ELECT 100μF 10V	EJ10701010
C112			ELECT 100μF 10V	EJ10701010
C113		4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C114			ELECT 47μF 10V	EJ47601010
C115		4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C116	330/331	4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C117	330/331	4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C118		4822 122 31765	CER. CHIP 100pF ±5% CG 50V	DD95101300
C119	330		CER. CHIP 2pF ±0.25pF CK	DD90020300
C120		4822 126 14417	CER. CHIP 0.01μF ±10% 50V K	DK96103300
C201		5322 126 11578	CER. CHIP 1000pF ±10% B	DK96102300
C202		5322 126 11578	CER. CHIP 1000pF ±10% B	DK96102300
C203			ELECT 100μF 10V	EJ10701010
C204		4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C205		4822 126 11685	CER. CHIP 4700P ±10% 50V	DK96472300
C206	330/331	4822 126 11685	CER. CHIP 4700P ±10% 50V	DK96472300
C207			ELECT 100μF 10V	EJ10701010
C208		4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C209		5322 126 11578	CER. CHIP 1000pF ±10% B	DK96102300
C210		5322 126 11578	CER. CHIP 1000pF ±10% B	DK96102300
C211		5322 126 11578	CER. CHIP 1000pF ±10% B	DK96102300
C212		5322 126 11578	CER. CHIP 1000pF ±10% B	DK96102300
C213		4822 126 11568	CER. CHIP 470pF ±10%	DK96471300
C214			CER. CHIP 0.22μF ±10% B 16V	DK56224200
C215	330/331	4822 126 11568	CER. CHIP 470pF ±10%	DK96471300
C216		4822 126 14417	CER. CHIP 0.01μF ±10% 50V K	DK96103300
C217			CER. CHIP 0.47μF ±10% 16V B	DK56474200
C218	331	4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C251	340	4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C252	340	4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C253	340	4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C254	340		ELECT 100μF 10V	EJ10701010
C255	340	4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C256	340	4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C257	340	4822 126 13837	CER. CHIP 0.1μF ±10% B 10V	DK96104200
C258	340	4822 126 13396	CER. CHIP 0.047μF ±10% 16V	DK96473200
P101-RESISTORS				
R101		4822 051 30681	CHIP 680Ω ±5% 1/16W	NN05681610
R102		4822 051 30681	CHIP 680Ω ±5% 1/16W	NN05681610
R103		4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
R104		4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
R105		4822 117 12925	CHIP 47kΩ ±5% 1/16W	NN05473610
R106		4822 051 30153	CHIP 15kΩ ±5% 1/16W	NN05153610
R107		4822 051 30102	CHIP 1kΩ ±5% 1/16W	NN05102610
R108		4822 051 30152	CHIP 1.5kΩ ±5% 1/16W	NN05152610
R109		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
R110		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
R111		4822 051 30333	CHIP 33kΩ ±5% 1/16W	NN05333610
R112		4822 051 30333	CHIP 33kΩ ±5% 1/16W	NN05333610
R113		4822 051 30562	CHIP 5.6kΩ ±5% 1/16W	NN05562610
R114		4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
R116		4822 117 12891	CHIP 220kΩ ±5% 1/16W	NN05224610
R117		4822 051 30102	CHIP 1kΩ ±5% 1/16W	NN05102610
R118		4822 051 30102	CHIP 1kΩ ±5% 1/16W	NN05102610
R121		4822 117 13632	CHIP 100kΩ ±5% 1/16W	NN05104610
R123		4822 117 13632	CHIP 100kΩ ±5% 1/16W	NN05104610

POS. NO	VERS. COLOR	PART NO. (FOR PCS)	DESCRIPTION	PART NO. (MJI)
R124		4822 051 30102	CHIP 1kΩ ±5% 1/16W	NN05102610
R125		4822 117 12902	CHIP 8.2kΩ ±5% 1/16W	NN05822610
R126	330/331	4822 051 30332	CHIP 3.3kΩ ±5% 1/16W	NN05332610
R130				
R131	330/331	4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
R133	330/331	4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
R134		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
R135		4822 117 12902	CHIP 8.2kΩ ±5% 1/16W	NN05822610
R137	330/331	4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
R201		4822 051 30683	CHIP 68kΩ ±5% 1/16W	NN05683610
R202		4822 051 30683	CHIP 68kΩ ±5% 1/16W	NN05683610
R203		4822 051 30272	CHIP 2.7kΩ ±5% 1/16W	NN05272610
R204		4822 051 30184	CHIP 180kΩ ±5% 1/16W	NN05184610
R205		4822 051 30184	CHIP 180kΩ ±5% 1/16W	NN05184610
R206		4822 051 30333	CHIP 33kΩ ±5% 1/16W	NN05333610
R207		4822 117 12891	CHIP 220kΩ ±5% 1/16W	NN05224610
R208		4822 117 12891	CHIP 220kΩ ±5% 1/16W	NN05224610
R209		4822 116 83819	CHIP 18kΩ ±5% 1/16W	NN05183610
R210	330/331	4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
R211	330/331	4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
R212	330/331	4822 051 30472	CHIP 4.7kΩ ±5% 1/16W	NN05472610
R213	330/331	4822 051 30102	CHIP 1kΩ ±5% 1/16W	NN05102610
R214		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
R215		4822 051 30153	CHIP 15kΩ ±5% 1/16W	NN05153610
R216		4822 051 30123	CHIP 12kΩ ±5% 1/16W	NN05123610
R217	331/340	4822 051 30153	CHIP 15kΩ ±5% 1/16W	NN05153610
R251	340		CHIP 82Ω ±5% 1/10W	NI05820110
R252	340		CHIP 82Ω ±5% 1/10W	NI05820110
R253	340	4822 051 30682	CHIP 6.8kΩ ±5% 1/16W	NN05682610
R254	340	4822 051 30682	CHIP 6.8kΩ ±5% 1/16W	NN05682610
R255	340	4822 051 30682	CHIP 6.8kΩ ±5% 1/16W	NN05682610
R256	340	4822 117 13632	CHIP 100kΩ ±5% 1/16W	NN05104610
R257	340	4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
R258	340	4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
R259	340		CHIP 2.2Ω ±5% 1/10W	NI05022110
R260	340		CHIP 2.2Ω ±5% 1/10W	NI05022110
R261	340		CHIP 2.2Ω ±5% 1/10W	NI05022110
R262	340	4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
R263	340	4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
R264	340	4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
R265	340	4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
R266	340		CHIP 2.2Ω ±5% 1/10W	NI05022110
P101-SEMICONDUCTORS				
Q101	330/331	9965 000 01600	IC TZA1022 HF AMP/LA CONT	HC10180490
Q102		9965 000 01720	IC NJM2137M-TE1 DUAL OP	HC10206090
Q103		4822 209 30455	IC NJM2100M JRC	HC10085090
Q104		4822 130 61906	DIG.TRS. DTC114EU	BA20035210
Q105		4822 130 61906	DIG.TRS. DTC114EU	BA20035210
Q106		4822 130 60731	CHIP TRS. 2SA1036K Q R	HX110362B0
Q107		4822 130 61906	DIG.TRS. DTC114EU	BA20035210
Q108		4822 130 11357	DIG.TRS. RN2307 DTA114YU	BA12307000
Q109		9965 000 01601	THERMISTOR	HH50005780
			TN10-4C103JT 10k	
Q110	331/340	4822 130 61906	DIG.TRS. DTC114EU	BA20035210
Q112	340	9965 000 01601	THERMISTOR	HH50005780
			TN10-4C103JT 10k	
Q201		4822 209 16372	IC TDA7073AT	HC10165490
			SOP DUAL BTL DRIVER	
Q202		4822 209 16372	IC TDA7073AT	HC10165490
			SOP DUAL BTL DRIVER	
Q203	331/340	9965 000 01601	THERMISTOR	HH50005780
			TN10-4C103JT 10k	
Q251	340	4822 209 16877	IC BA6856FP	HC10213210
			3PH-MOTOR DRIVER	
Q252	340	4822 130 60731	CHIP TRS. 2SA1036K Q R	HX110362B0

POS. NO	VERS. COLOR	PART NO. (FOR PCS)	DESCRIPTION	PART NO. (MJI)
J101 J102 J202			P101-MISCELLANEOUS JACK 16FMZ-ST FFC CONN. JACK 20FE-ST-VK-N 20PIN JACK 11FM-1.0ST FFC CONN.	YJ07020820 YJ07020160 YJ07020830
L801	/F, /U		P801-TRANS CIRCUIT BOARD MAINS TRANSF. EI-57 100V/120V	TS15747010
L801	/N	9965 000 01599	MAINS TRANSF. EI-57 230V	TS15747020
C851 L851 S851		4822 122 33276 4822 157 70419 4822 276 13364	P851-POWER SW CIRCUIT BOARD CER. DE7150 F 103M VA1 KC LF-4D-102 PUSH SWITCH SDDL1 POWER TV-3	DK17103840 FN01020020 SP01011990
CT52 CT53 CT56 CT57 CT58 CT59	331/340 331/340 331/340 331/340 331/340 331/340	4822 124 41537	PB01-XLR CONN. CIRCUIT BOARD [PMD331/340] PB01-CAPACITORS ELECT. 220µF M 6.3V RA-2 CER. 50V DC 0.1µF +80 -20% CER. 0.01µF ±10% 50V CER. 0.01µF ±10% 50V CER. 220pF ±10% 50V CER. 220pF ±10% 50V	OA22700620 DD38104010 DK16103300 DK16103300 DK16221300 DK16221300
RT52 RT53	331/340 331/340		PB01-RESISTORS 56Ω ±5% 1/6W 56Ω ±5% 1/6W	GG05560160 GG05560160
QT52	331/340	5322 209 60473	PB01-SEMICONDUCTOR IC SN75158/P TEXAS INST.	HC10071370
JB53 JB54 JT53	331/340 331/340 331/340		PB01-MISCELLANEOUS JACK NC3MAH 3P CANNON JACK NC3MAH 3P CANNON JACK NC3MAH 3P CANNON	YJ01004070 YJ01004070 YJ01004070
LT52 LT53 LT54	331/340 331/340 331/340	4822 242 73843 4822 148 81381	EMI FILTER DSS306-91-F-223Z PULSE TRANSF. TC-1086-26 FERRITE CORE BL02RN1-R62T2	FM12223010 TP33842010 FC90050040
LT55	331/340		FERRITE CORE BL02RN1-R62T2	FC90050040
CB01 CB02) CB06 CB07) CB13 CB14) CB21	331/340 331/340 331/340 331/340 331/340 331/340	4822 124 90354 4822 124 90352 4822 124 90354	PD01-MAIN CIRCUIT BOARD PD01-CAPACITORS ELECT. 100µF M 16V RA-2 ELECT. 10µF M 16V RA-2 ELECT. 100µF M 16V RA-2	OA10701620 OA10601620 OA10701620
CD01 CD01 CD02 CD03 CD04 CD05 CD06 CD07 CD08 CD09	330/331 340 340 340 340 340 340 340 340 340	4822 126 11685 4822 126 4822 126 13396 5322 126 11578 5322 126 11578 4822 126 14417 4822 126 13396 4822 126 12495 5322 126 11578	CER. CHIP 4700pF ±10% B 50V CER. CHIP 3300pF ±10% B 50V CER. CHIP 0.047µF ±10% X7R CER. CHIP 1000pF ±10% B CER. CHIP 1000pF ±10% B CER. CHIP 0.01µF ±10% 50V K CER. CHIP 0.47µF ±10% 16V B CER. CHIP 0.047µF ±10% X7R CER. CHIP 1500P ±10% 50V CER. CHIP 1000P ±10% 50V	DK96472300 DK96332300 DK96473200 DK96102300 DK96102300 DK96103300 DK56474200 DK96473200 DK96152300 DK96102300
CD10 CD11 CD12 CD13 CD14 CD15 CD16 CD17 CD18 CD19 CD19 CD20 CD21 CD22 CD23		9965 000 00599 9965 000 00599 4822 126 13837 4822 122 32672 5322 124 41744 4822 126 13689 4822 122 33752 4822 126 13837 4822 126 13396 4822 126 11671 5322 126 14449 4822 122 33753 4822 126 13689 5322 126 11578 4822 122 31765	CER. CHIP 0.22µF ±10% B 10V CER. CHIP 0.22µF ±10% B 10V CER. CHIP 0.1µF ±10% B 10V TANTL.CHIP 1µF 16V ELECT. 4700µF 10V RA-2 CER. CHIP 18pF ±5% CER. CHIP 15pF ±5% CG 50V CER. CHIP 0.1µF ±10% B 10V CER. CHIP 0.047µF ±10% X7R CER. CHIP 33pF ±5% CG 50V CER. CHIP 39pF ±5% CG 50V CER. CHIP 150pF ±5% CG 50V CER. CHIP 18pF ±5% CG 50V CER. CHIP 1000pF ±10% B CER. CHIP 100pF ±5% CG 50V	DK96224200 DK96224200 DK96104200 EY10501610 OA47801020 DD95180300 DD95150300 DK96104200 DK96473200 DD95330300 DD95390300 DD95151300 DD95180300 DK96102300 DD95101300
CM01 CT01 CT03 CT04 CT07 CT08		5322 122 32654 4822 126 13837 4822 126 12339 4822 126 13837 4822 126 13837 4822 124 22275	CER. CHIP 0.022µF ±10% 16V CER. CHIP 0.1µF ±10% B 10V CER. CHIP 2200P ±10% 50V CER. CHIP 0.1µF ±10% B 10V CER. CHIP 0.1µF ±10% B 10V ELECT. 47µF M 10V RA-2	DK96223200 DK96104200 DK96222300 DK96104200 DK96104200 OA47601020
CU01 CU02 CU03 CU04 CU05 CU41 CU51 CU53 CU54 CU60) CU79 CU80 CU91		4822 122 33752 4822 122 33752 4822 126 13837 4822 126 13837 4822 124 41543 4822 126 13837 4822 124 90352 4822 126 13837 5322 126 11578 5322 126 11578 4822 126 13837 4822 126 13837	CER. CHIP 15pF ±5% CG 50V CER. CHIP 15pF ±5% CG 50V CER. CHIP 0.1µF ±10% B 10V CER. CHIP 0.1µF ±10% B 10V ELECT. 1µF M 50V RA-2 CER. CHIP 0.1µF ±10% B 10V ELECT. 10µF M 16V RA-2 CER. CHIP 0.1µF ±10% B 10V CER. CHIP 1000pF ±10% B CER. CHIP 1000pF ±10% B CER. CHIP 0.1µF ±10% B 10V CER. CHIP 0.1µF ±10% B 10V	DD95150300 DD95150300 DK96104200 DK96104200 OA10505020 DK96104200 OA106016

POS. NO	VERS. COLOR	PART NO. (FOR PCS)	DESCRIPTION	PART NO. (MJI)
C801	330	4822 124 22243	ELECT 6800μF 16V RE3	OA68801620
C801	331/340		ELECT 10000μF 16V RE3	EA10901670
C802			CER. 0.1μF +80%-20% 50V	DD38104010
C803			CER. 0.1μF +80%-20% 50V	DD38104010
C804		4822 124 90371	ELECT. 470μF M 10V RA-2	OA47701020
C805			CER. 0.1μF +80%-20% 50V	DD38104010
C806			CER. 0.1μF +80%-20% 50V	DD38104010
C807		4822 124 90371	ELECT. 470μF M 10V RA-2	OA47701020
C808		4822 124 11583	ELECT. 2200μF M 35V RA-2	OA22803520
C809		4822 124 11583	ELECT. 2200μF M 35V RA-2	OA22803520
C810			CER. 0.1μF +80%-20% 50V	DD38104010
C811			CER. 0.1μF +80%-20% 50V	DD38104010
C812			CER. 0.1μF +80%-20% 50V	DD38104010
C813			CER. 0.1μF +80%-20% 50V	DD38104010
C814		4822 124 22277	ELECT. 470μF 16V M RA-2	OA47701620
C815		4822 124 22277	ELECT. 470μF 16V M RA-2	OA47701620
C816		4822 124 41543	ELECT. 1μF M 50V RA-2	OA10505020
PD01-RESISTORS				
RB01	331/340	9965 000 01716	VARIABLE 10kΩ B	RK01031580
RB02	331/340	9965 000 01716	VARIABLE 10kΩ B	RK01031580
RB03	331/340	4822 051 30221	CHIP 220Ω ±5% 1/16W	NN05221610
RB04	331/340	4822 051 30221	CHIP 220Ω ±5% 1/16W	NN05221610
RB05	331/340	4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RB06	331/340	4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RB07	331/340	4822 051 30682	CHIP 6.8kΩ ±5% 1/16W	NN05682610
RB08	331/340	4822 051 30682	CHIP 6.8kΩ ±5% 1/16W	NN05682610
RB09	331/340	4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
RB10	331/340	4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
RB11	331/340	4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
RB12	331/340	4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
RB13				
RB24	331/340	4822 051 30472	CHIP 4.7kΩ ±5% 1/16W	NN05472610
RB25				
RB28	331/340	4822 051 30479	CHIP 47Ω ±5% 1/16W	NN05470610
RB29				
RB32	331/340	4822 051 30472	CHIP 4.7kΩ ±5% 1/16W	NN05472610
RB33				
RB36	331/340	4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RD01		4822 051 30222	CHIP 2.2kΩ ±5% 1/16W	NN05222610
RD02		4822 051 30153	CHIP 15kΩ ±5% 1/16W	NN05153610
RD03		4822 051 30153	CHIP 15kΩ ±5% 1/16W	NN05153610
RD04		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
RD05		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RD06		4822 117 13632	CHIP 100kΩ ±5% 1/16W	NN05104610
RD07		4822 051 30332	CHIP 3.3kΩ ±5% 1/16W	NN05332610
RD08		4822 051 30332	CHIP 3.3kΩ ±5% 1/16W	NN05332610
RD09		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RD10		4822 051 30105	CHIP 1MΩ ±5% 1/16W	NN05105610
RD11		4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
RD12		4822 117 12925	CHIP 47kΩ ±5% 1/16W	NN05473610
RD13		4822 051 30333	CHIP 33kΩ ±5% 1/16W	NN05333610
RD15		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
RD16		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RD17		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RD18		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RD19		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RD20		4822 051 30102	CHIP 1kΩ ±5% 1/16W	NN05102610
RD22		4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
RD23	331	4822 116 83819	CHIP 18kΩ ±5% 1/16W	NN05183610
RD23	340	4822 051 30153	CHIP 15kΩ ±5% 1/16W	NN05153610
RM01		4822 111 90967	FUSE 4.7Ω J 1/4W	NF05047140
RM02		4822 051 30681	CHIP 680Ω ±5% 1/16W	NN05681610
RT02		4822 051 30221	CHIP 220Ω ±5% 1/16W	NN05221610

POS. NO	VERS. COLOR	PART NO. (FOR PCS)	DESCRIPTION	PART NO. (MJI)
RT03		4822 051 30331	CHIP 330Ω ±5% 1/16W	NN05331610
RT04		4822 051 30759	CHIP 75Ω ±5% 1/16W	NN05750610
RU01		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RU02		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RU04		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
RU05	330/331	4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
RU06		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
RU07		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
RU08		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
RU09		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RU10	330/340	4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
RU11				
RU21		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RU22		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
RU23				
RU27		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RU28		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
RU30		4822 051 30105	CHIP 1MΩ ±5% 1/16W	NN05105610
RU31		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
RU32	330	4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RU41		4822 051 30472	CHIP 4.7kΩ ±5% 1/16W	NN05472610
RU42		4822 051 30472	CHIP 4.7kΩ ±5% 1/16W	NN05472610
RU51		4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
RU52		4822 117 12925	CHIP 47kΩ ±5% 1/16W	NN05473610
RU53		4822 116 83819	CHIP 18kΩ ±5% 1/16W	NN05183610
RU54		4822 051 30479	CHIP 47Ω ±5% 1/16W	NN05470610
RU55		4822 051 30102	CHIP 1kΩ ±5% 1/16W	NN05102610
RU58		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RU60	331/340	4822 051 30102	CHIP 1kΩ ±5% 1/16W	NN05102610
RU62				
RU74	331/340	4822 051 30102	CHIP 1kΩ ±5% 1/16W	NN05102610
RU80				
RU90	331/340	4822 117 12925	CHIP 47kΩ ±5% 1/16W	NN05473610
RU91		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
RU92		4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
RU93	331/340	4822 117 12925	CHIP 47kΩ ±5% 1/16W	NN05473610
RU94	331/340	4822 117 12925	CHIP 47kΩ ±5% 1/16W	NN05473610
RU95	331/340	4822 117 12925	CHIP 47kΩ ±5% 1/16W	NN05473610
R301	331/340	4822 051 30474	CHIP 470kΩ ±5% 1/16W	NN05474610
R501		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
R502		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
R503		4822 051 30472	CHIP 4.7kΩ ±5% 1/16W	NN05472610
R504		4822 051 30472	CHIP 4.7kΩ ±5% 1/16W	NN05472610
R505		4822 116 83819	CHIP 18kΩ ±5% 1/16W	NN05183610
R506		4822 116 83819	CHIP 18kΩ ±5% 1/16W	NN05183610
R507		4822 051 30333	CHIP 33kΩ ±5% 1/16W	NN05333610
R508		4822 051 30333	CHIP 33kΩ ±5% 1/16W	NN05333610
R509		4822 051 30123	CHIP 12kΩ ±5% 1/16W	NN05123610
R510		4822 051 30123	CHIP 12kΩ ±5% 1/16W	NN05123610
R511		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
R512		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
R513		4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
R514		4822 051 30223	CHIP 22kΩ ±5% 1/16W	NN05223610
R515		4822 051 30151	CHIP 150Ω ±5% 1/16W	NN05151610
R516		4822 051 30151	CHIP 150Ω ±5% 1/16W	NN05151610
R517		4822 117 12925	CHIP 47kΩ ±5% 1/16W	NN05473610
R518		4822 117 12925	CHIP 47kΩ ±5% 1/16W	NN05473610
R519		4822 051 30471	CHIP 470Ω ±5% 1/16W	NN05471610
R520		4822 051 30471	CHIP 470Ω ±5% 1/16W	NN05471610
R531	330	4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
R532	330	4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
R533	330	4822 116 82487	CHIP 0Ω ±5% 1/16W	NN05000610
R541	331/340	4822 117 13632	CHIP 100kΩ ±5% 1/16W	NN05104610
R542	331/340	4822 051 30222	CHIP 2.2kΩ ±5% 1/16W	NN05222610

POS. NO	VERS. COLOR	PART NO. (FOR PCS)	DESCRIPTION	PART NO. (MJI)	POS. NO	VERS. COLOR	PART NO. (FOR PCS)	DESCRIPTION	PART NO. (MJI)
R543	331/340	4822 051 30222	CHIP 2.2kΩ ±5% 1/16W	NN05222610	JD01			PD01-MISCELLANEOUS	
R544	331/340	4822 051 30102	CHIP 1kΩ ±5% 1/16W	NN05102610	JT01		4822 267 31729	JACK 20FE-BT-VK-N 20PIN	YJ07020530
R801					JT02	331/340	4822 267 31369	TERMINAL 14X14 RA 1L1P BLK	YT02010780
R805		4822 051 30472	CHIP 4.7kΩ ±5% 1/16W	NN05472610	JU01			OPT. CONN.GP1F32T	YJ15000090
					JU51			OPTICAL OUTPUT	
DB01	331/340	4822 130 83715	CHIP DIODE 1SS301 DAN202U	HZ21005000	JU53	331/340	4822 265 11401	JACK 30PIN 30FMN-BMTTR-TB	YJ07016500
DB02	331/340	4822 130 83715	CHIP DIODE 1SS301 DAN202U	HZ21005000	J501		4822 267 31727	TERMINAL RCA JACK ORG	YT02021090
DM02		9965 000 01598	CHIP DIODE UDZS8.2B MA8082-M	HZ30821000				PLUG D-SUB 25P FEMALE	YP11000180
DU01		9965 000 01491	CHIP DIODE DA227	HZ20032210				TERMINAL 14X14 RCA 2L2P	YT02021210
DU02		9965 000 01491	ARRAY 2PIECES-2125	HZ20032210	LB01	331/340	9965 000 01343	RELAY RELAY MR62-12SR	LY20120510
DU03		4822 130 83715	CHIP DIODE 1SS301 DAN202U	HZ21005000	LB02	331/340	9965 000 01343	RELAY RELAY MR62-12SR	LY20120510
DU51		4822 130 83715	CHIP DIODE 1SS301 DAN202U	HZ21005000	LD01			CHIP INDUCTANCE	LU04472010
DU52		4822 130 83715	CHIP DIODE 1SS301 DAN202U	HZ21005000	LD02			4.7μH ±10% 1608 TYPE	LU04472010
D501		4822 130 83715	CHIP DIODE 1SS301 DAN202U	HZ21005000	LD03			CHIP INDUCTANCE	LU04471010
D502		4822 130 81324	CHIP DIODE 1SS302	HZ20018050	LD04			0.47μH ±10% MLF1608	LU04471010
▲ D801		4822 130 83067	DIODE D3SB 20	HE20020290	LT01		4822 142 60388	0.47μH ±10% MLF1608	TP41042010
			V=200V IO=3.0A		LT02			PULSE TRANSF. FOR CD	FC90020120
▲ D802		4822 130 10413	DIODE BRIDGE D2SBA20	HE20027290	LT03	331/340		FERRIT BEADS	FC90020120
D803		4822 130 83715	CHIP DIODE 1SS301 DAN202U	HZ21005000	L501		9965 000 01343	BK1608HM102-T	FC90020120
								FERRIT BEADS	
QB01					SU51		4822 277 21789	BK1608HM102-T	LY20120510
QB04	331/340	4822 209 83357	IC NJM4560M JRC	HC10029090	XD01		4822 242 10883	RELAY MR62-12SR	SS02020970
QD01		9965 000 01437	IC CXD2585Q CD DECODER	HC10069250	XU01		9965 000 01597	SLIDE SWITCH SSSUI-6MM	JX16002360
QD02	331/340	9965 000 01601	THERMISTOR	HH50005780				CRYSTAL CM309S	JX20001360
QM01		4822 209 30193	IC LB1641 MOTOR DRIVER	HC10279030				16.9344MHz CITIZEN	
QU01		9965 000 01492	MICROPROCESSOR	HU371KH00F				CRYSTAL CM309S 20MHz	
QU03		9965 000 01595	HD643306ZF MPU	HC10074990	CV01			PV01-HEAD PHONE	
QU04		9965 000 01596	IC AT25640	HC809449R0	CV02			CIRCUIT BOARD	
QU41		4822 130 60731	64K EEPROM	HX110362B0	CV03			PV01-CAPACITORS	
QU42		4822 130 61906	IC 74HC4094BT FLAT	BA20035210	CV04			ELECT 100μF 16V RC-2	EJ10701610
QU51		4822 130 60669	CHIP TRS. 2SA1036K Q R	HX300012A0				ELECT 100μF 16V RC-2	EJ47601610
QU52		4822 130 61906	DIG.TR.S. DTC114EU	BA20035210				ELECT 47μF 16V	EJ47601610
QU53		4822 130 11357	CHIP TRS. 2SC4081 Q R	BA12307000	RV01		4822 051 30153	ELECT 47μF 16V	
QU55		4822 130 11357	2SC4116 Y GR	BA12307000	RV02		4822 051 30153		
QU56		9965 000 01596	DIG.TR.S. DTC114EU	BA12307000	RV03		4822 051 30103	CHIP 15kΩ ±5% 1/16W	NN05153610
QU57		4822 209 17428	DIG.TR.S. RN2307 DTA114YU	HC809449R0	RV04		4822 051 30103	CHIP 15kΩ ±5% 1/16W	NN05103610
QU58		4822 209 17428	IC 74HC165F	HC716500R0	RV05		9965 000 01489	CHIP 10kΩ ±5% 1/16W	NN05103610
QU59		4822 209 17428	IC 74HC165F	HC716500R0	RV06		9965 000 01489	CHIP 10kΩ ±5% 1/16W	RI05121120
QU64		4822 130 61906	DIG.TR.S. DTC114EU	BA20035210	RV07		4822 051 30472	CHIP 120Ω ±5% 1/2W	RI05121120
QU91		4822 209 30426	IC CMOS 74HC00 FLAT	HC700000Z0	RV08		4822 051 30472	CHIP 4.7kΩ ±5% 1/16W	NN05472610
Q301	331/340	9965 000 01717	IC RL5C357 SHOCK PROOF	HC10042770	RV09		9965 000 01490	CHIP 4.7kΩ ±5% 1/16W	NN05472610
Q302	331/340	9965 000 01718	IC HY5117400BJ-60 DRAM	HC10089990				VARIABLE 50kΩ A L=15MM	RM05033070
Q501		4822 209 15226	IC PCM1710U 16/20BIT DAC	HC10004610	QV01		4822 209 31378	PV01-SEMICONDUCTOR	HC10045090
Q502		4822 209 83357	IC NJM4560 FLAT PACK JRC	HC10029090				IC NJM4556AM JRC	
Q541	331/340	4822 130 11357	DIG.TR.S. RN2307 DTA114YU	BA12307000	JV02		4822 267 31126	PV01-MISCELLANEOU	YJ01003020
Q542	331/340	4822 130 43818	TRS. 2SC2878 A OR B	HT328782A0				JACK ST HEADPHONE BL/GL	
Q543	331/340	4822 130 43818	TRS. 2SC2878 A OR B	HT328782A0					
▲ Q801		4822 209 83824	IC NJM7805FA +5V 1A JRC	HC38905090	CY01		9965 000 01438	PY01-DISPLAY	EY22505020
▲ Q802		4822 209 73674	IC NJM7806FA +6V 1A JRC	HC38906090	CY02		9965 000 01438	CIRCUIT BOARD	EY22505020
▲ Q803		4822 209 82829	IC NJM78M15FA +15V 0.5A	HC38515090	CY03		9965 000 01438	PY01-CAPACITORS	EY22505020
▲ Q804		4822 209 83828	IC NJM79M15FA -15V 0.5A	HC39515090	CY04		4822 124 23002	TANTL.CHIP 2.2μF 50V	EY10601620
Q805		4822 130 61906	DIG.TR.S. DTC114EU	BA20035210	CY05		4822 126 14417	TANTL.CHIP 2.2μF 50V	DK96103300
Q806		4822 130 61906	DIG.TR.S. DTC114EU	BA20035210	CY06		4822 124 11226	TANTL.CHIP 10μF 16V	DK96103300
					CY07		4822 126 14417	CER. CHIP 0.01μF ±10% 50V K	DK96103300
					CY08		4822 126 14417	CER. CHIP 0.01μF ±10% 50V K	DK96103300
					CY09		4822 126 14417	CER. CHIP 0.01μF ±10% 50V K	DK96103300

POS. NO	VERS. COLOR	PART NO. (FOR PCS)	DESCRIPTION	PART NO. (MJI)
CY10 } CY17		5322 126 11578	CER. CHIP 1000pF ±10% B	DK96102300
			PY01-RESISTORS	
RY01		9965 000 01444	VARIABLE 100kΩ B W/CLIC	RB01040080
RY02		4822 051 30332	CHIP 3.3kΩ ±5% 1/16W	NN05332610
RY03		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RY04		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RY05		4822 051 30273	CHIP 27kΩ ±5% 1/16W	NN05273610
RY06		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RY07		4822 051 30103	CHIP 10kΩ ±5% 1/16W	NN05103610
RY08		4822 117 12864	CHIP 82kΩ ±5% 1/16W	NN05823610
RY09		4822 051 30101	CHIP 100Ω ±5% 1/16W	NN05101610
RY11		4822 051 30101	CHIP 100Ω ±5% 1/16W	NN05101610
RY12		4822 051 30101	CHIP 100Ω ±5% 1/16W	NN05101610
RY13		4822 051 30121	CHIP 120Ω ±5% 1/16W	NN05121610
RY14		4822 051 30121	CHIP 120Ω ±5% 1/16W	NN05121610
RY15		4822 051 30121	CHIP 120Ω ±5% 1/16W	NN05121610
RY16		4822 051 30121	CHIP 120Ω ±5% 1/16W	NN05121610
RY17		4822 051 30101	CHIP 100Ω ±5% 1/16W	NN05101610
RY18		4822 117 12891	CHIP 220kΩ ±5% 1/16W	NN05224610
RY19		4822 051 30121	CHIP 120Ω ±5% 1/16W	NN05121610
RY20		4822 051 30221	CHIP 220Ω ±5% 1/16W	NN05221610
			PY01-SEMICONDUCTORS	
DY01 }		9965 000 01439	L.E.D. FY1101F-TX YELLOW CHIP	HI10010300
DY06 DY07		9965 000 01440	L.E.D. SML-310DT ORANGE CHIP	HI10103210
DY08		9965 000 01440	L.E.D. SML-310DT ORANGE CHIP	HI10103210
DY09 }		9965 000 01441	L.E.D. SML-310MT GREEN CHIP	HI10104210
DY12 DY13 }		9965 000 01440	L.E.D. SML-310DT ORANGE CHIP	HI10103210
DY18				
QY01		9965 000 01442	IC HD66712SA02FS LCD DRIV.	HC10132010
QY02		4822 130 60669	CHIP TRS. 2SC4081 Q R 2SC4116 Y GR	HX300012A0
QY05		9965 000 01443	DISPLAY UNIT LCD	HQ22801800
QY06		4822 130 61906	DIG.TRS. DTC114EU	BA20035210
QY07		4822 130 61906	DIG.TRS. DTC114EU	BA20035210
QY08		4822 130 61906	DIG.TRS. DTC114EU	BA20035210
QY09		4822 130 61906	DIG.TRS. DTC114EU	BA20035210
			PY01MISCELLANEOUS	
JY01 JY03			JACK 30PIN 30FMN-BMTTR-TB JUMPER LEAD ZEBRA CONN.	YJ07016500 YU01009700
SY14 } SY28		9965 000 01445	TACT SWITCH SKHMPW	SP01013320
			PY41-IR SENSOR CIRCUIT BOARD	
QY41		4822 130 10161	PHOTO UNIT SPS-446-4 IR SENSOR SANYO	HW10005030
			PY51-PITCH DIAL CIRCUIT BOARD FOR PMD331/340	
SY51	331/340	9965 000 01719	ROTARY SWITCH EC16B2410207 L=20 HOL	SR01240020